

iXon Ultra 888

VERSION 1.0 REVISED 27 MARCH 2015



Hardware Guide

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REVISION HISTORY

Version	Released	Description
1.0	27 Mar 2015	Initial Release. This new hardware guide has been developed from iXon Ultra 897 guide and updated specifically for the Ultra 888 model.

SAFETY AND WARNING INFORMATION

**PLEASE READ THIS INFORMATION FIRST**

1. To ensure correct and safe operation of this product, please read this guide before use and keep it in a safe place for future reference.
2. If the equipment is used in a manner not specified by Andor, the protection provided by the equipment may be impaired.
3. Before using the system, please follow and adhere to all warnings, safety, manual handling and operating instructions located either on the product or in this guide.
4. The Andor iXon Ultra 888 camera is a precision scientific instrument containing fragile components. Always handle with care.
5. The camera should be mounted so that the mains supply can be easily disconnected. In case of emergency, the disconnecting device is the mains lead. This will either be the mains lead connected to the product or, in the case of a cabinet-based system, the mains lead to the cabinet.
6. Use only the power supply cord provided with the system for this unit. Should this not be correct for your geographical area contact your local Andor representative.
7. Only the correctly specified mains supply must be used.
8. Make sure the electrical cord is located so that it will not be subject to damage.
9. The product contains components that are extremely sensitive to static electricity and radiated electromagnetic fields, and therefore should not be used, or stored, close to EMI/RFI generators, electrostatic field generators, electromagnetic or radioactive devices, or other similar sources of high energy fields.
10. Operation of the system close to intense pulsed sources (e.g. plasma sources, arc welders, radio frequency generators, X-ray instruments, and pulsed discharge optical sources) may compromise performance if shielding of the Camera is inadequate.
11. This product is not designed to provide protection from ionising radiation. Any customer using this product in such an application should provide their own protection.
12. The Andor iXon Ultra is for use in research laboratories and other controlled scientific environments.
13. This equipment has not been designed and manufactured for the medical diagnosis of patients.
14. Do not expose the product to extreme hot or cold temperatures.
15. Ensure that the ventilation slots in the camera case are free from blockages.
16. Do not expose the product to open flames.
17. Do not allow objects to fall on the product.
18. Do not expose the product to moisture, wet, or spill liquids on the product. Do not store or place liquids on the product. If spillage occurs on the product, switch off power immediately and wipe off with dry, lint-free cloth. If any ingress has occurred or is suspected, unplug mains cable, do not use, and contact Andor service.
19. There are no user-serviceable parts in the camera. If the head is opened the warranty will be void. Only authorised service personnel may service this equipment.
20. Users must be authorised and trained personnel only; otherwise this may result in personal injury, and/or equipment damage and impaired system performance. Electromagnetic Compatibility: This is a "FCC Class A" product. In a domestic environment this product may cause electromagnetic interference, in which case the user may be required to take adequate measures.

SAFETY AND WARNING SYMBOLS

The following are explanations of the symbols found on this product:



This product has been tested to the requirements of CAN/CSA-C22.2 No. 61010-1, 2nd edition, including Amendment 1, or a later version of the same standard incorporating the same level of testing requirements



The iXon Ultra camera requires a Direct Current (DC) supply.



Refer to this guide before use

MANUAL HANDLING

Due to the delicate nature of some of the components within, care must be exercised when handling this product. Proper manual handling techniques are important when unpacking and installing the system to ensure that the integrity of the product is safeguarded and individuals involved are not exposed to unnecessary manual handling risks, such as:

- Lifting a load that is too heavy
- Poor posture or technique during lifting
- Dropping a load
- Lifting objects with sharp edges

SHIPPING AND STORAGE CONDITIONS

Unpacking and Inspection:

- Carefully unpack the unit and retain packaging to return equipment for servicing.
- If the equipment appears damaged in any way, return it to sales outlet in its original packaging. No responsibility for damage arising from the use of non-approved packaging will be accepted.
- Ensure all items and accessories specified in **Section 1.5** are present.

If any items are missing, please contact your local sales representative.

SECTION 1: INTRODUCTION

Thank you for choosing the **Andor iXon Ultra 888**. You are now in possession of a revolutionary new Electron Multiplying Charge Coupled Device (EMCCD), designed for the most challenging low-light imaging applications. This Hardware Guide contains useful information and advice to ensure you get the optimum performance from your new system.

INTRODUCTION

1.1 TECHNICAL SUPPORT

If you have any questions regarding the use of this equipment, please contact the representative* from whom your system was purchased, or:

Europe

Andor Technology
7 Millennium Way
Springvale Business Park
Belfast
BT12 7AL
Northern Ireland
Tel. +44 (0) 28 9023 7126
Fax. +44 (0) 28 9031 0792

www.andor.com/contact_us/support_request

USA

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Suite # 3
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CT 06074
USA
Tel. +1 (860) 290-9211
Fax. +1 (860) 290-9566

www.andor.com/contact_us/support_request

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Tokyo 101-0064
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www.andor.com/contact_us/support_request

China

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Room 1213, Building B
Luo Ke Time Square
No. 103 Huizhongli
Chaoyang District
Beijing, 100101 P.R.
China
Tel: +86 (0)10 51294977
Fax. +86(0)10-6445-5401

www.andor.com/contact_us/support_request

* The latest contact details for your local representative can be found on our website.

INTRODUCTION

1.2 DISCLAIMER

THE INFORMATION CONTAINED HEREIN IS PROVIDED “AS IS” WITHOUT WARRANTY, CONDITION OR REPRESENTATION OF ANY KIND, EITHER EXPRESS, IMPLIED, STATUTORY OR OTHERWISE, INCLUDING BUT NOT LIMITED TO, ANY WARRANTY OF MERCHANTABILITY, NON-INFRINGEMENT OR FITNESS FOR A PARTICULAR PURPOSE.

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The copyright in this document and the associated drawings are the property of Andor Technology and all rights are reserved. This document and the associated drawings are issued on condition that they are not copied, reprinted or reproduced, nor their contents disclosed.

The publication of information in this documentation does not imply freedom from any patent or proprietary right of Andor Technology or any third party.

1.4 TRADEMARKS AND PATENT INFORMATION

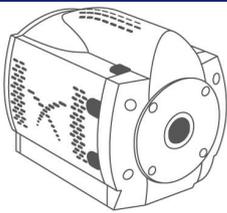
Andor and the Andor logo are trademarks of Andor Technology. Andor Technology is an Oxford Instruments company. All other marks are property of their owners. Changes are periodically made to the product and these will be incorporated into new editions of the manual.

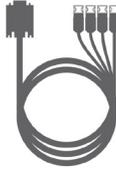
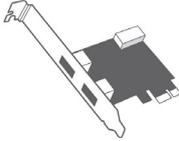
New releases of the manual are available through MyAndor: <http://my.andor.com/login.aspx>.

INTRODUCTION

1.5 SUPPLIED COMPONENTS

The Andor iXon Ultra 888 is supplied with the following standard components:

Description	Quantity
 <p>iXon Ultra 888 EMCCD Camera (with integrated C-mount shutter)</p>	1

Description	Quantity	Description	Quantity
 <p>USB 3.0 cable</p>	1 x 3 m	 <p>Mounting Posts (Ø1/2" x 80 mm long x 1/4-20 UNC)</p>	2
 <p>Multi I/O Timing cable ACZ-03463</p>	1 x 3 m	 <p>USB 3.0 PCI card</p>	1
 <p>Power Supply Unit (PS-90)</p>	1	 <p>Hardware Guide on CD</p>	1
 <p>Country specific Power Cord</p>	1	 <p>iXon Ultra 888 Quick Start Guide</p>	1
		C-mount Stopper	1

1.5.1 OPTIONAL COMPONENTS

- Software disk (SDK and/or Solis if ordered)
- Andor Programmer guide to Andor Basic (if ordered)
- Software Development Kit manual (if SDK ordered)
- OptoMask microscopy accessory, used to mask unwanted sensor area during Crop Mode acquisition (OPTOMASK).
- Re-circulator for enhanced cooling performance (XW-RECR)
- Oasis 160 Ultra compact chiller unit (ACC-XW-CHIL-160)
- C-mount to Nikon F-mount adapter (OA-CNAF)
- C-mount to Olympus adapter (OA-COFM)
- C-mount to T-mount adapter (OA-CTOT)

INTRODUCTION

1.6 CAMERA POWER SUPPLY UNIT (PSU)

The iXon Ultra powered from an external 12 V PS-90 PSU as shown in **Figure 2**.

Input Characteristics

- 100-240 V AC, 47-63 Hz
- 1.6 A (max)
- IEC input connector (3 pin)

Output Characteristics

- 12 V DC, 9 A max.
- Camera power consumption: 12 V at 6 A = 72 Watts
- 3 pin Redel cable plug

The iXon Ultra PSU is for use with Telecommunications, Computer, Industrial Controller and OA Systems and must only be used indoors.

⚠ The iXon Ultra 888 camera requires a Direct Current (DC) supply.



Figure 1: The PS-90 Power Supply

WARNING: The electrical mains lead should be certified for use in your country and in applicable countries the plug must be fitted with a 240V 5A fuse. If users use any other power supply, they do so at their own risk.

1.6.1 WORKING WITH ELECTRONICS

The computer equipment that is to be used to operate the iXon Ultra should be fitted with appropriate surge/EMI/RFI protection on all power lines. Dedicated power lines or line isolation may be required for some extremely noisy sites. Appropriate static control procedures should be used during the installation of the system. Attention should be given to grounding. All cables should be fastened securely into place in order to provide a reliable connection and to prevent accidental disconnection.

The circuits used in the camera head are extremely sensitive to static electricity and radiated electromagnetic fields and should not be used (or stored close to) EMI/RFI generators, electrostatic field generators, electromagnetic or radioactive devices, or other similar sources of high energy fields. Types of equipment that can cause problems include Arc welders, Plasma sources, Pulsed-discharge optical sources, Radio frequency generators and X-ray instruments.

1.7 PREVENTION OF CONDENSATION

Condensation may form on the outside of the camera body if the temperature of the cooling water is too low or if the water flow is too high. The first signs of condensation will usually be visible around the connectors where the water tubes are attached. In such circumstances switch off the system, disconnect the power supply and carefully wipe the camera with a soft, dry cloth. It is likely there will already be condensation on the cooling block and cooling fins inside the camera. Please also carry out the following actions:

- Set the camera aside to dry for several hours before you attempt re-use
- Before re-use, blow dry gas through the cooling slots on the side of the camera to remove any residual moisture
- Use warmer water or reduce the flow of water when you start using the device again
- Check Dew Point (refer to **Appendix B**)

1.8 EM GAIN AGEING

It has been observed that some EMCCD sensors, more notably in cameras that incorporate L3Vision sensors from e2v, are susceptible to EM Gain fall-off over a period of time. This ageing effect applies to any EMCCD camera manufacturer that incorporates L3Vision sensors into their cameras. The Andor iXon Ultra 888 model uses an L3Vision sensor.

A technical note entitled: '**EMCCD - RealGain™ & EMCAL™**', which further explains this phenomenon, can be downloaded from the Andor website: <http://www.andor.com/library/publications/?app=543>

1.8.1 MINIMIZING EM GAIN AGEING IN YOUR IXON ULTRA CAMERA

If left unchecked, EM Gain Ageing has the potential to significantly compromise the long-term quantitative reliability of EMCCD cameras. Andor has implemented innovative measures to stabilize the EM Gain on these sensors and ensure the long term quantitative stability to the user. If these guidelines are followed EM Gain Ageing can be minimized and should not present any real problem to the user.

More details of this ageing effect and Andor's solutions can be found on **Section 3.1.7**. Some of the guidelines to minimize the EM Gain ageing process are listed below:

- Do not use EM Gain values greater than necessary to overcome the read noise. A gain of x4 or x5 the rms read noise (accessible from the spec sheet or performance sheet) is more than sufficient to render this noise source negligible. In practice, this can be achieved with EM Gain of less than x300 at 10 MHz and x600 for 30MHz operation. Pushing gain beyond this value would give little or no extra Signal to Noise benefit and would only reduce dynamic range.
- Only select the extended EM Gain scale of x1000 for single photon counting applications and always ensure that the signal falling onto the sensor is within the regime of low numbers of photons per pixel.
- Turn down the gain when the camera is not acquiring.
- Try not to over-saturate the EMCCD sensor.

1.9 MINIMIZING PARTICULATE CONTAMINATION

It is important that particulate contamination of the exterior of the camera window is kept to a minimum, such that images are kept free of 'shadowing' particles directly in the optical path. The iXon Ultra range comes equipped with an internal C-mount shutter. Whilst not being required for frame transfer operation (which is a shutter-free readout mode) it is good practice to close the shutter when the camera is not in acquisition use for a reasonable period. It is also advisable to use the software to close the shutter when exposing the camera to the 'open environment' (i.e. removed from a microscope C-mount or focusing lens) whilst power is still flowing to the camera.

When exiting SOLIS the shutter (if fitted) will close automatically. We recommend that the C-mount opening is covered when the camera is not in use.

If there is evidence of particulate contamination on the front window it is possible to clean the window by blowing oil free dry air gently over the window surface. To ensure the shutter stays open, unplug power from the camera when Solis is running and the shutter is open. Exiting Solis abnormally will leave the shutter in the open state.

1.10 SOFTWARE

The iXon Ultra can be supplied with Andor Solis, iQ or SDK software. It is also compatible with a range of third party software options that support optimized acquisition control and analysis functionality. For further details of Andor software capabilities and software options, please go to the following page on our website: <http://www.andor.com/products/software/>

SECTION 2: PRODUCT OVERVIEW

2.1 IXON ULTRA 888

The iXon Ultra 888 combines the largest available 1024 x 1024 EMCCD sensor, USB 3.0 and optimized electronics within the iXon platform along to provide the highest performance and reliability available for an EMCCD camera.



Figure 2: iXon Ultra 888 EMCCD Camera

Features of the iXon Ultra 888 include:

- 1024 x 1024 active pixels / 13 μm pixel size
- 30 MHz readout - 26 fps
- 93 fps @ 512 x 512 (Crop Mode)
- Single photon sensitivity
- Back-illuminated > 90% QE_{max}
- USB 3.0 Connectivity
- Ultravac™ Technology

2.2 POWER AND SIGNAL CONNECTIONS

The power and signal connections are located on the base plate of the iXon Ultra 888:

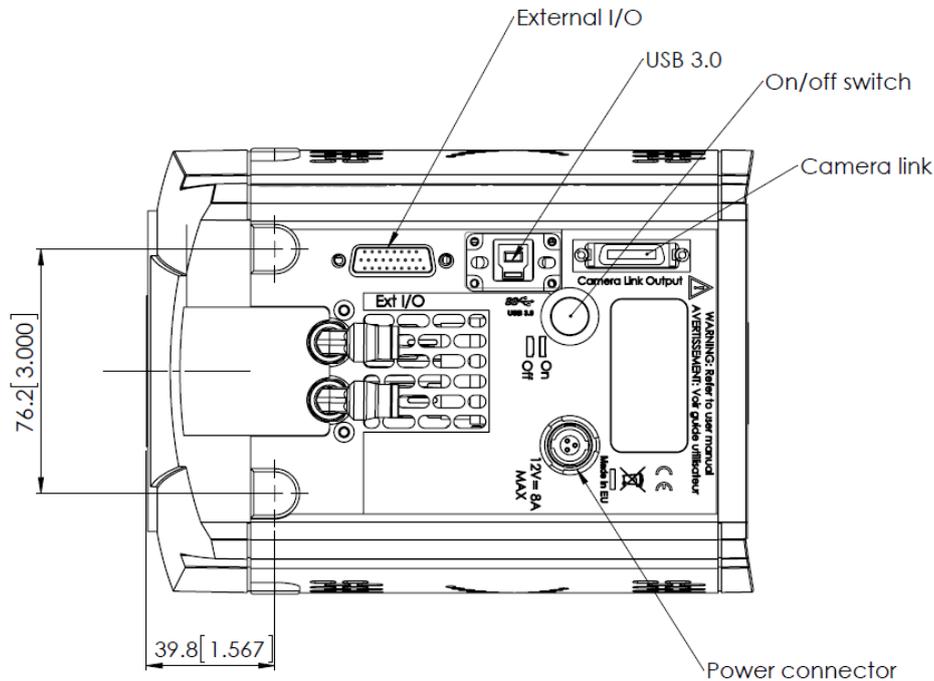


Figure 3: Power and Signal Connections of the Ixon Ultra 888

Power connector: For connection to the **Power Supply Unit (PSU)**. Note the connector is keyed and has a locking action.

USB 3.0: A USB connection should be made to the PC with the supplied USB 3.0 cable. Performance with other USB 3.0 cables/cards can not be guaranteed.

Ext I/O: The iXon Ultra is supplied with an ACZ-03463 cable for the external I/O connector. This provides industry-standard output **BNC** connectors:

- **Fire** (please refer to **Section 4.2**)
- **Shutter** (see **Section 4.3**)
- **Arm** (please refer to **Section 4.2**)
- **Ext. Trig (External Trigger Input)** (please refer to **Section 4.2**)

These are used to send and receive Trigger and Fire signals. The outputs (Fire & Shutter) are CMOS compatible & series terminated at source (i.e. in the camera) for a 50Ω cable.

NOTES:

1. The cable termination at the customer end should be high impedance ($>1K\Omega$) as an incorrect impedance match could cause errors with timing and triggering.
2. The External Trigger Input is TTL level, CMOS compatible and has $>10K\Omega$ impedance.
3. Signal diagrams of these connections are shown on Section 2.4. The interfaces and internal circuits of the iXon Ultra are rated as SELV (Safety Extra Low Voltage). All interfacing equipment should use SELV voltage and current levels.
5. OutputDAC1 and OutputDAC2 are 16-bit DAC outputs that can be configured by the user to be up to approximately 10.1 Volts. Maximum output current that can be drawn is 10mA
6. +5V Output is a 5V supply to signal to the user that the camera is powered up. The maximum current that can be drawn from this is 500mA
7. I/O bits (8 off) are user programmable and can either be inputs or outputs. When being used as inputs these default to being weakly pulled high. The maximum low level input voltage is 1.5V and the minimum high level input voltage is 3.5V. As outputs the maximum "high" level output current that can be drawn is 0.03mA and the maximum "low" level current that each output can sink is 10mA.

I²C: I²C connection point- 2 x16-bit DACs, and 8 digital i/os available on the External I/O. To access these connections requires an advanced cable (ACZ-03464) to connect to the 26 way High density D connector.

2.3 CAMERA LINK

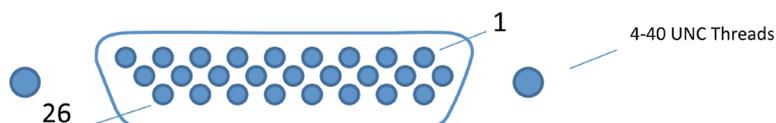
The iXon Ultra is equipped with a Base Configuration (3-tap interface) Camera Link output which conforms to the specification defined by the Automated Imaging Association (AIA). This provides access to the camera data output with very low latency. Note that this is an OUTPUT ONLY e.g for use with a Camera Link frame grabber or custom embedded applications.

A Technical Note "Camera Link Output" is available at:

<http://www.andor.com/learning-academy/camera-link-output-ixon-ultra-output-for-direct-data-access>

2.4 EXTERNAL I/O

The iXon Ultra has a 26 way high density D-type connector to enable full functionality.



26 Way D-type Conec 164A21019X

Figure 4: iXon Ultra I/O connector

Table 1: Pinouts for D-Type connector

1	External Trigger	10	I/O data bit 0	19	5 V Out
2	Trigger Invert	11	I/O data bit 1	20	GND
3	GND	12	I/O data bit 2	21	I ² C Data
4	Output DAC 1	13	I/O data bit 3	22	I ² C Clock
5	Output DAC 2	14	I/O data bit 4	23	Shutter Control Output
6	GND	15	I/O data bit 5	24	Arm Output
7	Frame Output	16	I/O data bit 6	25	GND
8	Fire Output	17	I/O data bit 7	26	GND
9	Reserved Output	18	GND		

NOTE: Pin 9 is a reserved pin as interline shift is not used on the iXon.

2.5 SIGNAL DIAGRAMS

2.5.1 IXON ULTRA INPUT & OUTPUT TIMING HARDWARE

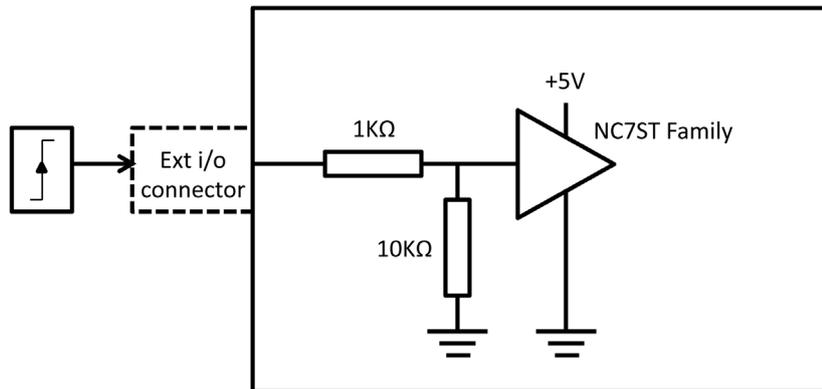


Figure 5: External Trigger

- VIH (High level input voltage, minimum) = 2.2V
- VIL (Low level input voltage, maximum) = 0.88V
- Change to falling edge trigger by connecting “Trigger Invert Input” pin to Ground with $\leq 500\Omega$

2.5.2 EXTERNAL TRIGGER INPUT (AT CONNECTOR)

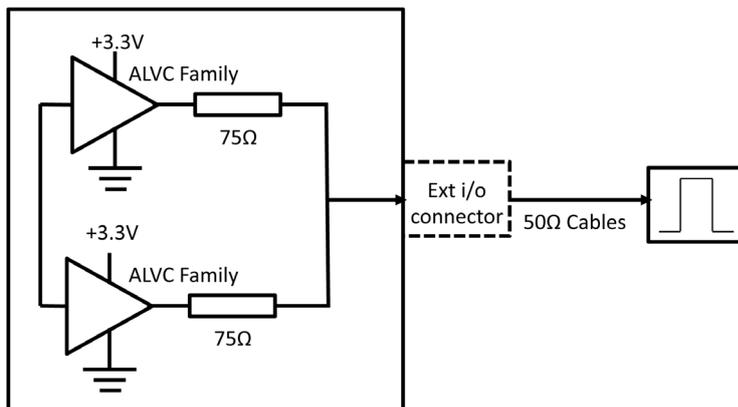


Figure 6: Fire & Shutter

Fire, Shutter, Arm & Frame Output (at connector)

- Use 50Ω cable + high impedance input ($>1k\Omega$)
- Drive both TTL & CMOS unterminated input

SECTION 3: INSTALLING THE IXON ULTRA 888

3.1 PC REQUIREMENTS

Install the camera software before first connecting the camera – this will ensure that USB drivers are available when required.

There are no restrictions on the order in which components are connected. It is best to allow a few seconds from camera power on (using either the button or a mains switch) to starting Solis in order for the camera to be recognised by the PC.

- 3 GHz Quad Core or 2.6 GHz multi core processor
- 2 GB RAM
- 100 MB free hard disc to install software (at least 1 GB recommended for data spooling)
- Solid-state drive (SSD) capable of a minimum sustained write speed of 100MB/S for spooling data
- USB 3.0 Super Speed Host Controller capable of sustained rate of 60MB/s
- Windows (Vista, 7 or 8) or Linux

3.2 CONNECTING THE CAMERA

1. Attach the camera to lens or optical system using the camera C-mount interface as required
2. Insert the 12V DC power cable from the PS-90 power supply into the power connector on the bottom plate of the camera, ensure the orientation is correct. NEVER forcibly insert the connector.
3. Connect the supplied USB 3.0 cable between the USB 3.0 connector on the camera and the corresponding slot on the PC. (A USB socket on the rear of a desktop machine is preferred). Only use USB 3.0 cables supplied by Andor as performance can not be assured with other models.
4. Switch the camera ON using the ON/OFF switch. You should hear an audible confirmation (camera start-up tone).

Note: The iXon Ultra has a power switch on the camera head for convenience.

5. The supplied Multi i/o cable may be required depending on the measurement being carried out. Refer to **Section 2.4** for details.
6. The camera can achieve stated performance with air cooling using the internal fan – Water cooling is also available see **Section 3.3** for details.

3.3 COOLING THE CCD

Heat is generated by the sensor during normal operation which if not addressed may have a significant adverse effect on performance (e.g. signal to noise ratio and sensitivity) due to increased dark current noise. The iXon Ultra range makes use of a four-stage Peltier cooling assembly (thermoelectric cooler, TEC), which utilizes the thermoelectric effect to rapidly cool the sensor down to the stable operating temperature. A TEC has a cold side (in contact with the sensor) and a hot side. Temperature control components regulate the cooling of the camera and ensure that a stable temperature is maintained between and throughout measurements.

The iXon Ultra can use either forced air cooling- using the in-built fan, or water cooling for enhanced cooling performance (refer to **Section 3.4** for connection information). When using water cooling, a re-circulator or a chiller can be purchased from Andor to provide a convenient and effective heat dissipation.

3.3.1 SOURCES OF HEAT GENERATION

In normal operation, clocking the image and storage regions of the EMCCD sensor, along with clocking the register, generates heat. The resistive heating process is dependent on the amplitude and frequency of the clocks, therefore the faster a sensor is clocked, the more heat is generated. A TEC is capable of providing a temperature difference (delta) between its cold and hot side that is dependent on the wattage of heat at the cold side (where the CCD is located). Therefore the minimum temperature the CCD can achieve is dependent on the heat produced by the sensor.

Equally, if the hot side of the TEC can be maintained at a lower temperature then the cold side will also be at a lower temperature, as the same delta is maintained. Air cooling the hot side achieves this by blowing air over the camera heat sink. The limitation of this is that the level of cooling is dependent on the temperature of the ambient environment. In the majority of cases this is sufficient, but if deeper cooling is necessary a water chiller or re-circulator can be employed. This will keep the hot side of the TEC at a lower temperature as the heat can be transmitted to the water more efficiently and the water temperature can also be controlled.

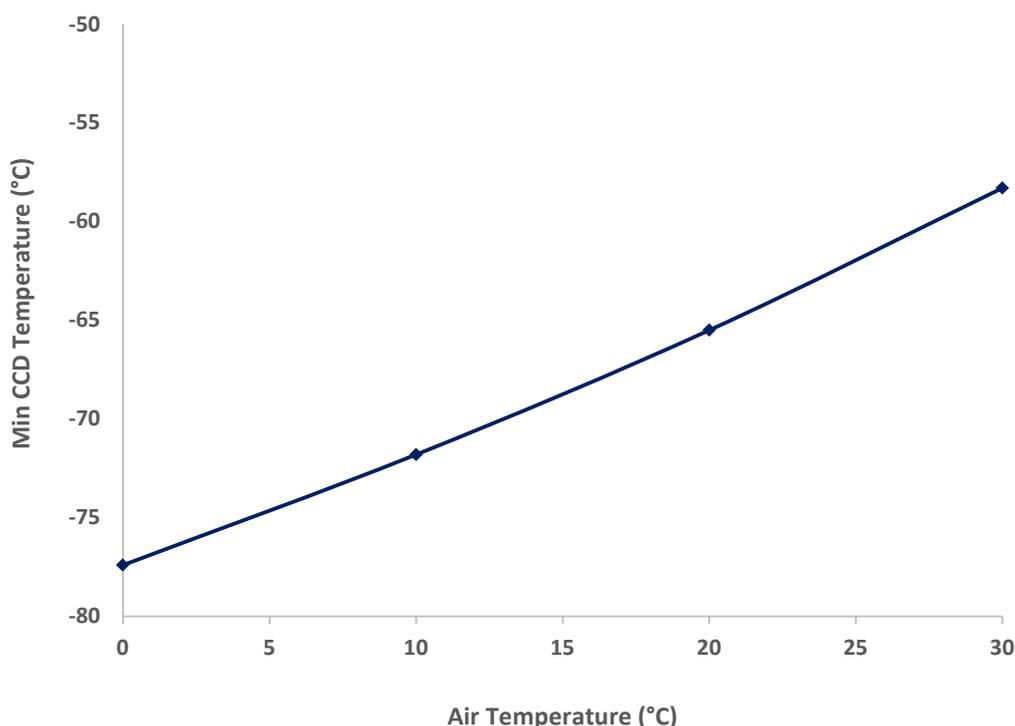


Figure 7: Minimum CCD temperature at varying air temperature.

3.3.2 MINIMUM ACHIEVABLE TEMPERATURES

The iXon Ultra 888 breaks new boundaries in the clocking speeds of EMCCDs and therefore the minimum achievable cooling will be impacted for some readout configurations. Clocking the image and storage regions of the sensor has by far the biggest impact on heat generation. As the serial register is clocked at speeds of up to 30 MHz, the time taken for each row of data to be readout is greatly reduced, reducing the time between vertical clocks and increasing the heat produced by the sensor. An example is shown in **Figure 8**. At a readout rate of 10 Mhz it is possible to achieve a minimum CCD temperature of -86°C whereas, when readout rate is increased to 30 MHz the minimum CCD temperature using the same acquisition settings is reduced by 20°C to -66°C .

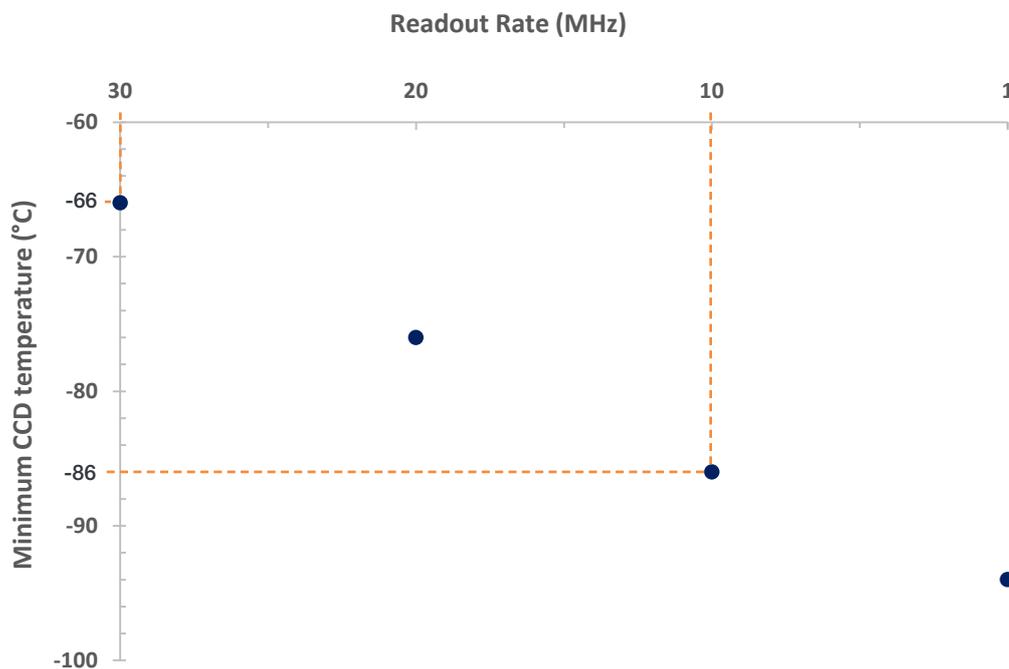


Figure 8: Minimum achievable temperature at each of the horizontal readout speeds for full frame readout and keeping all other parameters the same (Air cooled 20°C ambient).

Any acquisition sequence that increases the proportion of the readout time spent performing vertical shifts, will have a detrimental impact on the minimum achievable cooling. The acquisition settings that have the biggest impact on cooling are:

1. Small Regions Of Interest (ROI) for both standard and crop mode
2. Using vertical binning
3. Faster vertical shift speeds
4. Increased vertical clock amplitude

The impact of the ROI and Binning parameters on minimum achievable CCD temperatures are shown for a range of examples in **Table 2**.

Table 2: The effect of ROI type and size and Binning on minimum achievable CCD Temperature

ROI Type	ROI	Binning	CCD Min (°C)
Standard	1024 x 1024	1 x 1	-66
Standard	512 x 512	1 x 1	-50
Standard	256 x 256	1 x 1	-33
Standard	128 x 128	1 x 1	-10
Standard	512 x 512	2 x 2	-31
Standard	512 x 512	4 x 4	-8
Centre Crop Mode	512 x 512	1 x 1	-63
Centre Crop Mode	512 x 512	2 x 2	-51
Centre Crop Mode	512 x 512	4 x 4	-35
Centre Crop Mode	512 x 512	8 x 8	-19

Note: The above examples are indicative only and individual cameras will have some variation about these numbers. The data were taken at 30 MHz readout, 1.13 μ s vertical shift speed, minimum exposure and with the camera continuously acquiring. Please note that at these short exposures and maximum frame rates, the contribution to the signal from dark current is minimal, so deep cooling is not always critical to your measurement.

As stated earlier, the frequency and amplitude of the vertical clocks also affects the minimum achievable CCD temperatures. This is outlined below in **Table 3**.

Table 3: The effect of Vertical clock speed and amplitude on minimum achievable CCD temperature.

VS Speed (μ s)	Clock amplitude	CCD Min (°C)
4.3	Norm	-65
2.2	Norm	-63
1.13	Norm	-62
0.6*	Norm	-66
0.6*	+2	-61
0.6*	+4	-57

*At this vertical shift speed the image clocks don't reach their peak amplitude so heat generated is lessened. A clock amplitude increase is necessary at this speed to ensure charge is transferred.

3.3.3 HOW TO DETERMINE THE MINIMUM ACHIEVABLE TEMPERATURE FOR YOUR SPECIFIC ACQUISITION SETTINGS

Determine the minimum achievable temperature for your particular acquisition settings as follows:

1. Set the temperature control to -100°C
2. Run the camera for 10 to 20 minutes at your specific acquisition settings.
3. When the camera has stabilised at a particular temperature (for example -53°C) you should set the temperature controller to be a few degrees above this (so for this example -50°C).
4. This will ensure that when you come to run your experiment, the camera will be able to maintain the set temperature.

3.4 CONNECTING A COOLING SYSTEM

3.4.1 HOSE CONNECTIONS

Two barbed coolant hose inserts are supplied as standard with the iXon Ultra camera, suitable for connection to 6 mm (0.25") internal diameter soft PVC tubing / hose.

Recommended tubing: 10 mm (0.4") outside diameter, i.e. a wall thickness of 2 mm (0.08").

Alternative hose dimensions and materials should be thoroughly tested to ensure a leak tight seal is achieved with the barbed inserts.

3.4.2 COOLANT RECOMMENDATIONS

It is recommended that de-ionized water (without additives) is used as the coolant to prevent deposits forming. Some mains supply water is heavily mineralized (i.e. "Hard") which could cause deposits in the water circuit inside the camera. This can reduce the flow-rate, and therefore, the cooling efficiency.

The specified cooling performance of the camera can be achieved with coolant flow rates of >0.75 litres per minute, the maximum recommended pressure of coolant circulating through the camera head is 2 bar (30 PSI).

In the event that replacement hose inserts / barbs are required, please contact your local Andor representative.

CAUTION: Always ensure that the temperature of the liquid coolant circulated through the camera head is above the dew point of the camera ambient. Use of coolant at or below the dew point will result in permanent damage to the camera head, due to formation of condensation on internal components (refer to Appendix B).

3.4.3 CONNECTING THE COOLANT HOSES

1. Secure the hose to the barbs on the hose inserts
2. Click both hose inserts into the quick-release couplings on the side of the camera
3. Ensure the hose inserts are located securely in place



Figure 9: Hose inserts and quick release coupling

3.4.4 REMOVING THE COOLANT HOSES

CAUTION: Before attempting to remove the hose connections, ensure that all water has been drained from the hoses and the coolant channel within the camera head. Care must be taken to avoid permanent damage to the camera system resulting from either leakage of coolant during connection / removal of hoses or spillage of any residual coolant contained within the camera head once the hoses have been removed.

1. Depress the collar on the quick-release couplings
2. The hose insert connections will now be released and can be disconnected from the quick-release coupling

3.5 MOUNTING POSTS

There are 4 pairs of mounting post positions on all four sides of the camera. These can be used to mount the camera if the C-Mount is not used, or to mount accessories. Each pair of holes has a 2.0" spacing.

NOTE: A bag containing two $\text{\O}1/2''$ x 80 mm long x 1/4-20 UNC posts is included with all kits

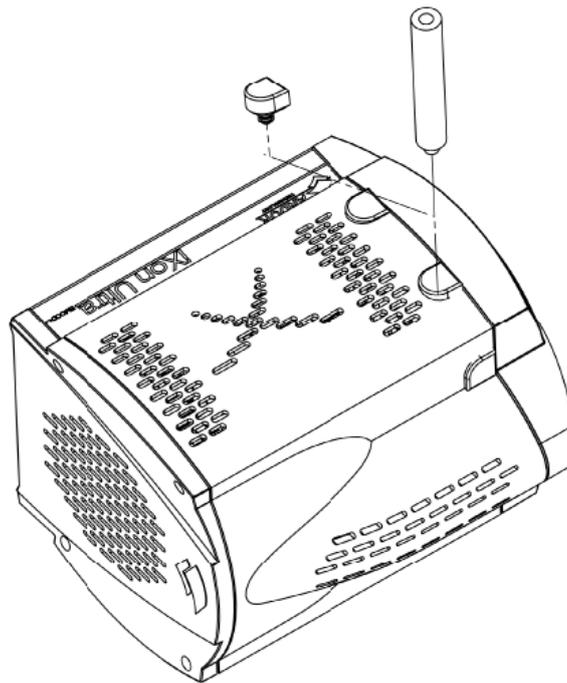


Figure 10: Attaching the Mounting Posts

3.5.1 ATTACHING MOUNTING POSTS TO THE CAMERA

1. Carefully remove the black grommet(s) as shown in **Figure 5**.
2. Screw each mounting post into the exposed mounting hole
3. Tighten using a screwdriver shank through the hole in the mounting post

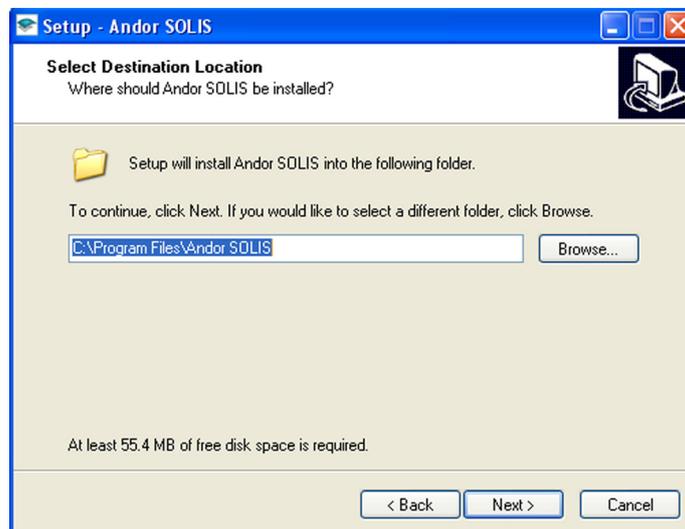
NOTE: Store the blanking grommets so they may re-installed if the mounting posts are not in use.

3.6 INSTALLING ANDOR SOLIS SOFTWARE FOR WINDOWS (VISTA, 7 AND 8)

1. Terminate and exit any programmes that are running on the PC.
2. Insert the Andor CD. The **InstallShield Wizard** now starts (this will vary slightly depending on your version of Windows software). If it does not start automatically, run the file **setup.exe** directly from the CD then follow the on-screen prompts.

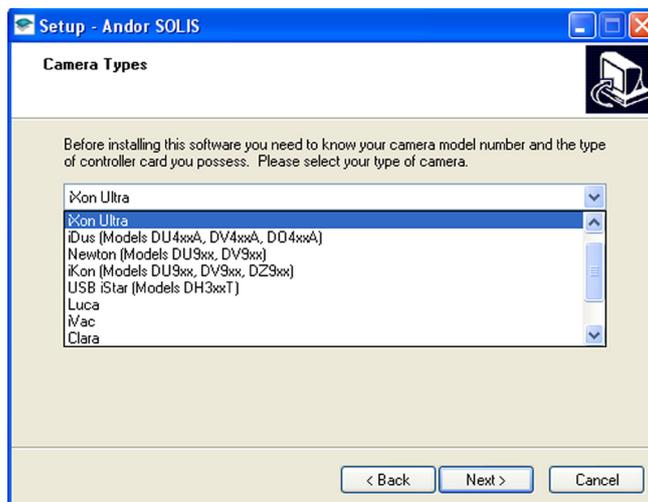


3. Click **Next >** and the following dialog box appears.

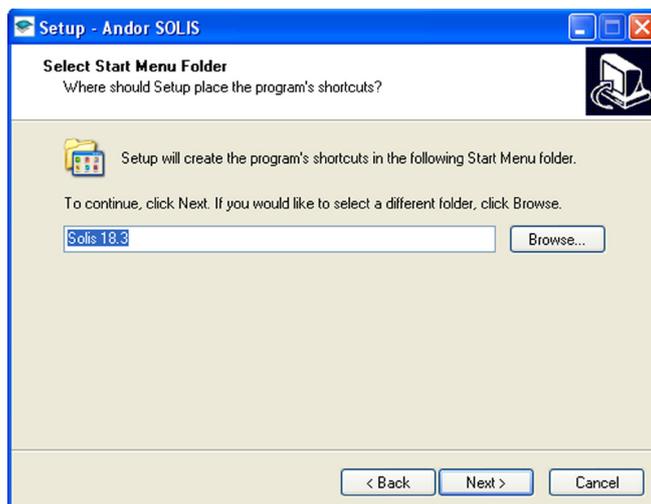


4. Click **Next >** (alternatively, click on Browse..., choose your own file destination then click **Next >**)

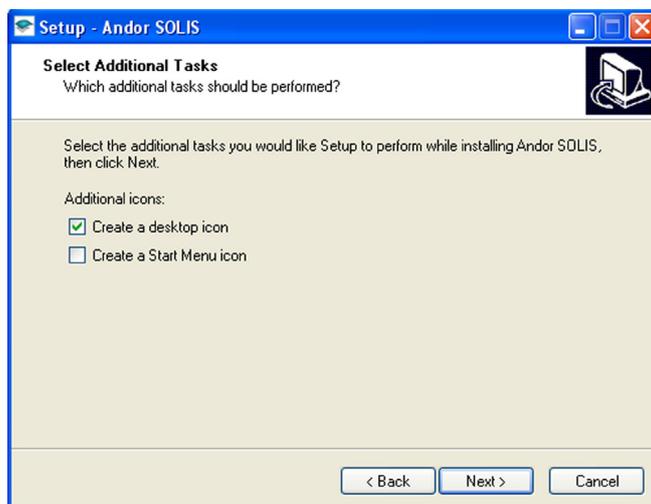
5. Select **iXon Ultra**, then click **Next>** and the following dialog box appears.



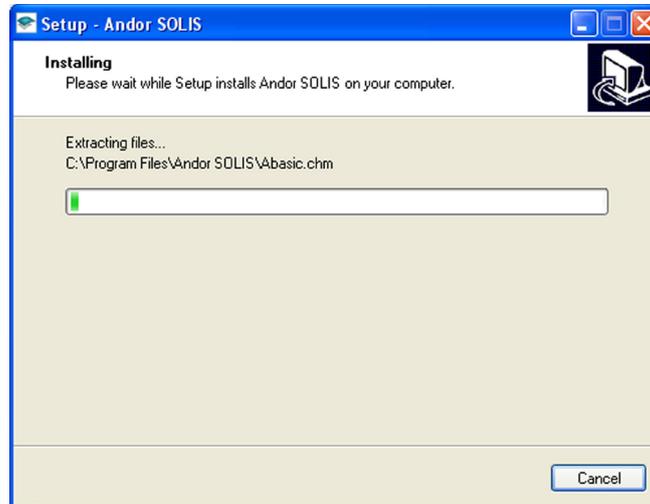
6. Click **Next >** (alternatively, click on **Browse...**, choose your own shortcut destination then click **Next >**).



7. Select (or de-select) the additional tasks to be performed during the set-up, then click **Next>**.



- Click **Install** to continue with the installation (or click **<Back**, if you want to review / change any settings. When **Install** is pressed an update progress bar appears while the installation is performed, e.g.



- When the hardware installation is complete, the following screen appears.



3.7 NEW HARDWARE WIZARD

When the first iXon Ultra camera is connected to a PC for the first time, the **Found New Hardware Wizard** screen appears:



1. Select the **'No, not this time only'** option then click **Next>** and the following screen appears:

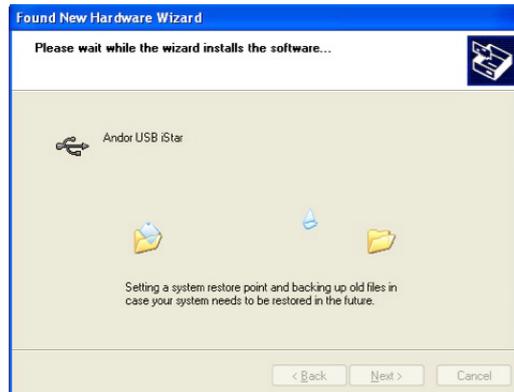


2. Select the **'Install from a list or specified location (Advanced)'** option then click **Next>**. The following screen appears.



3. Navigate to the directory where the Andor Solis software was installed to on the PC, then click **Next>**

4. The installation wizard runs, e.g.



5. When hardware installation is complete, the following screen appears.



6. Click the **Finish** button to complete the installation.

NOTE: If the camera is connected to a different USB port, steps 1 – 6 will have to be repeated on the first connection only. This is a feature of how Windows deals with the USB interface.

NOTE: On the first startup of Solis, you may be required to direct the software to the iXon Ultra drivers. If so, select the directory that Andor Solis was installed to.

3.8 START-UP DIALOG

On start-up of Solis software a dialog may appear (similar to that shown below) if multiple cameras are connected to your PC.



Figure 11: Start Up Dialog Menu

1. Highlight the **Andor iXon Ultra** camera (The Serial Number can be found on the label on the camera)
2. Click **OK** to continue with the selected camera.

SECTION 4: TRIGGERING INFORMATION

This section describes the **Keep Clean Cycles** and **Triggering** modes for the iXon Ultra 888.

4.1 KEEP CLEAN CYCLES

iXon Ultra cameras have a range of different Keep Clean Cycles that run depending on the actual model and the state the camera is in. The first Keep Clean Cycle runs while the camera is in an idle state, i.e. waiting for the PC to tell it to start an acquisition sequence. The next Keep Clean Cycle runs during an internal trigger kinetics series sequence. The final Keep Clean Cycle runs while the camera is waiting for an external trigger event to occur.

4.1.1 IDLE KEEP CLEAN CYCLE

When the camera is idle, i.e. not actively acquiring images, it repeatedly runs the **Idle Keep Clean Cycle**. This cycle is composed of a vertical shift, followed by a series of horizontal shifts. The number of horizontal shifts is dependent on the number of elements which make up a row. When the Start command is received from the PC, the camera completes the current "Idle Keep Clean Cycle" and then performs a sufficient number of vertical shifts to ensure both Image and Storage regions are completely charge free, see **Figure 12**. This is enough for any charge in the top most row to be transferred through the storage area, to the register, and then read out.

On completion of this sequence the camera is ready to run the exposure sequence. The exact exposure sequence will depend on several factors including the trigger and the readout modes selected. These will be discussed later in this document.

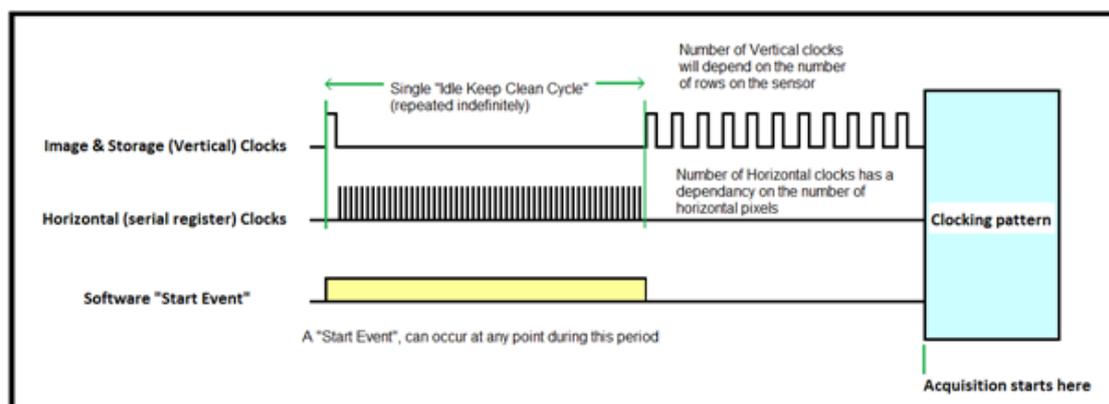


Figure 12: Idle Keep Clean Cycle - Clocking pattern depends on the acquisition modes and are discussed separately.

4.1.2 INTERNAL KEEP CLEAN CYCLE

The second type of Keep Clean Cycle is called the **Internal Keep Clean Cycle**. It is performed between individual scans in a kinetic series, and is relevant to Non-Frame Transfer Mode combined with either Internal or Software Trigger.

When the user configures a kinetics series acquisition, as well as defining the exposure time and the readout mode, they also define the number of scans to capture and the time between the scans. During the time between individual scans the sensor must be kept free of charge to ensure the data captured is a true reflection of the light that fell on it during the exposure period. The Keep Clean Cycle run during this time is very similar to that described in the Idle Keep Clean Cycle, in that the cycle is one vertical followed by a series of horizontals. In this mode, however, the number of times the cycle is repeated is determined by the cycle time set by the user. The Keep Clean Cycle is completed with a sufficient number of vertical shifts to ensure both the Image and Storage areas are charge free.

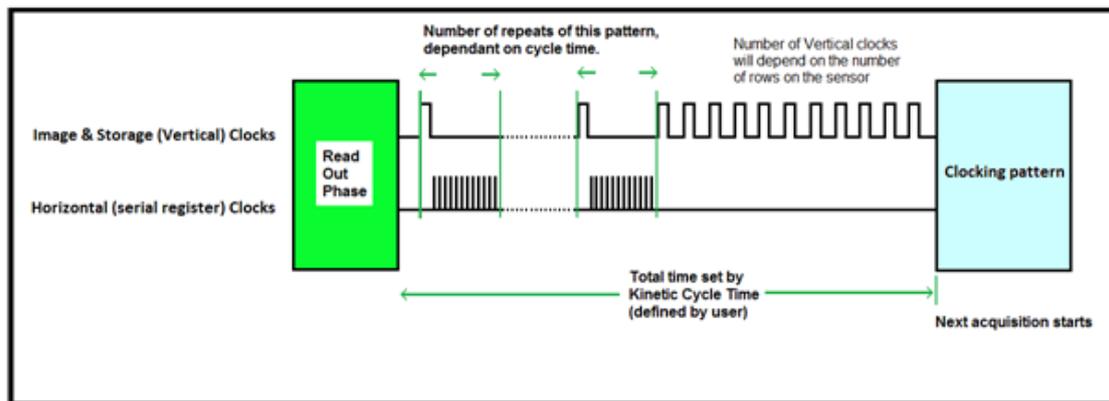


Figure 13: Internal Keep Clean Cycle - Once readout of a frame occurs, system repeats a pattern of clocking to keep image and storage regions clear of charge, the number being dependant on the kinetic series cycle time.

4.1.3 EXTERNAL KEEP CLEAN CYCLE

The third Keep Clean Cycle is the **External Keep Clean Cycle**. This cycle uses a different sequence of horizontal and vertical clocking, as it must be able to respond to external events extremely rapidly, but at the same time keep the image area of the sensor charge free. The External Keep Clean Cycle consists of continuous cycles of one vertical shift, both Image and Storage, followed by reading out one full row, one horizontal shift (see **Figure 14**). When an external trigger is detected the current cycle completes before the exposure phase starts. It is worth noting that although the External Keep Clean Cycle will complete the current cycle, this will *not* result in the total loss of signal during this time period, as only one vertical shift will have occurred. For pulsed light of very short time duration, picoseconds (i.e. of the order of one vertical shift), the resultant image may appear to have shifted one row.

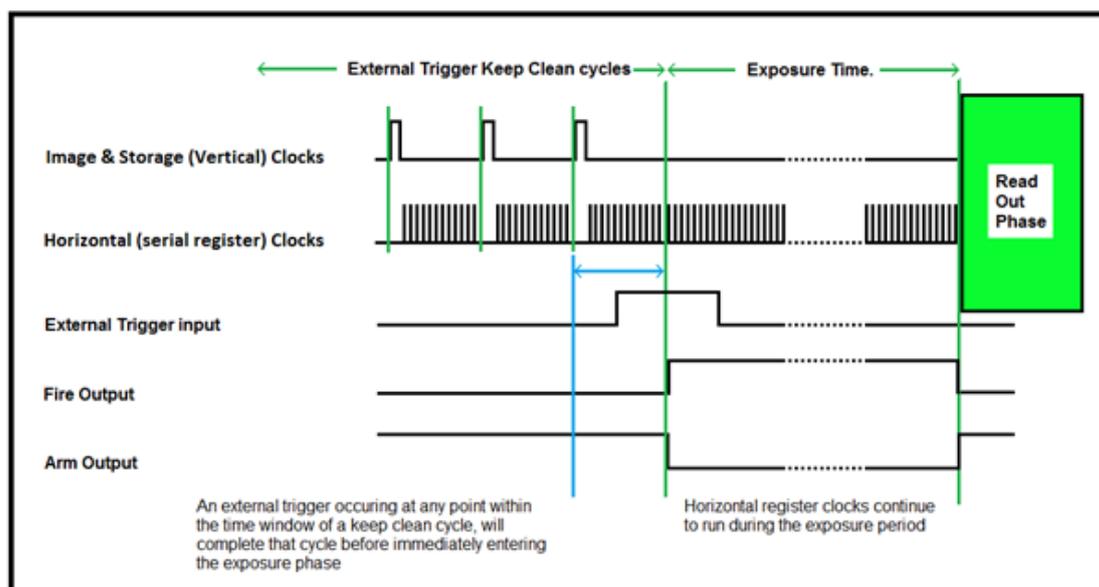


Figure 14: The External Trigger Keep Clean Cycle - consists of shifting one row down, and then reading that whole row out. When a trigger event is registered, the current cycle will complete before system goes straight to the exposure phase.

4.1.4 iXON SERIES KEEP CLEAN INFORMATION

The following table provides a summary of the differences in the keep clean cycles between the various iXon models.

	iXon x3	Ultra 897	Ultra 888
Idle	1 Vertical Shift X Horizontal Shifts	1 Vertical Shift X Horizontal Shifts	1 Vertical Shift X Horizontal Shifts
Internal	1 Vertical Shift X Horizontal Shifts (repeated at least Y times)	2 Vertical Shift X Horizontal Shifts (repeated at least Y times)	3 Vertical Shift X Horizontal Shifts (repeated at least Y times)
External	1 Slow Vertical Shift 1 Horizontal Shift	2 Fast Verticals N Horizontals (N set to suit Exposure)	1 Vertical Shift X Horizontal Shifts
Trigger Latency (min)	13 μ S	Varies with readout speed and Vertical shift rate (300nS - 6 μ S)	1 Horizontal shift time (30nS - 1 μ S)
Trigger Latency (max)	27 μ S	Varies with readout speed and Vertical shift rate (600nS - 500 μ S)	(300nS - 6 μ S)

where:

X is number of Horizontal pixels in image

Y is number Vertical pixels in image

N is a variable calculated by the camera

Notes

- Ultra 897 has enhanced measurement stability in External trigger mode relative to X3
- Trigger latency in Ultra 897 is higher than X3 for lower readout speeds
- Trigger latency in Ultra 888 varies with readout speed and vertical shift rate but is lower and has less jitter than X3

4.2 TRIGGERING MODES

The iXon Ultra camera has several different triggering modes. These include **Internal**, **External (and Fast External)**, **External Start**, **External Exposure** and **Software Trigger**. Note also that many of these features require iCam technology within the camera, fuller details of which can be viewed through www.andor.com

- In **Internal Trigger** the camera determines the exact time when an exposure happens, based on the acquisition settings entered by the user. This is the most basic trigger mode and requires no external intervention.
- In **External Trigger**, once an acquisition starts, the camera is placed into “External Keep Clean Cycle”, which ensures that charge built up on the CCD is kept to a minimum while waiting for the external trigger event. The External Keep Clean Cycle consists of a continuous sequence of one vertical shift followed by a variable number of horizontal shifts. Once the External Trigger is received the current Keep Clean Cycle is completed and the exposure phase initiated. The exact nature of the acquisition will depend on the user settings and is explained in more detail in a subsequent section. The external trigger is fed via the **Ext Trig** input on the camera.
- **Fast External Trigger** is for the most part identical to External Trigger - it differs in only one key aspect. In Fast External Trigger the camera does not wait for a sufficient number of Keep Clean Cycles to have been completed to ensure the image area is completely clean of charge before accepting an external trigger event but, instead, allows a trigger event to *immediately* start the acquisition process. As a result, Fast External Trigger allows a higher frame rate than standard External Trigger. **NOTE: If the delay between triggers is sufficiently long for the image to be swept clear - external and fast external are equivalent**
- **External Start** is a mixture of External and Internal Trigger. In this mode the camera performs a sequence of External Keep Clean Cycles while waiting for one external trigger event to occur before starting the acquisition process. Once this external trigger event has occurred, the camera will switch to internal trigger and the acquisition progresses as if the camera was in Internal Trigger mode.
- **External Exposure Trigger** is a mode of operation where the exposure time is fully controlled by the external trigger input. While the trigger input is high, the CCD accumulates charge in the Image area. When the External Trigger goes low, the accumulated charge is quickly shifted into the Storage area and then read out in the normal manner.
- **Software Trigger** is a mode whereby the camera and software are in a high state of readiness and can react extremely quickly to a trigger event issued via software. This mode is particularly useful when the user needs to control other equipment between each exposure, and does not know in advance how long such control will take, or if the time taken changes randomly.

These Triggering modes are explained and illustrated in more detail in the following sections.

4.3 TRIGGERING OPTIONS IN FRAME TRANSFER (FT) MODE

4.3.1 INTERNAL TRIGGERING

Internal Triggering is the simplest mode of operation, in that the camera determines when the exposure happens. By monitoring the Fire output, the user can determine exactly when the camera is “exposing”.

When the camera is idle, it runs the Idle Keep Clean Cycle (**Section 4.1.1**). On receipt of the Start command from the PC, the camera completes the current Keep Clean Cycle and then performs sufficient vertical shifts to ensure that the Image and Storage regions are completely free of charge. (i.e. Enough vertical shifts for the top row of the image area, to be brought down through storage area and into the register). The camera then starts its real exposure sequence, for which the timing sequence is illustrated in the **Figure 15**. At this time, the horizontal clocks are still running, clearing out the register.

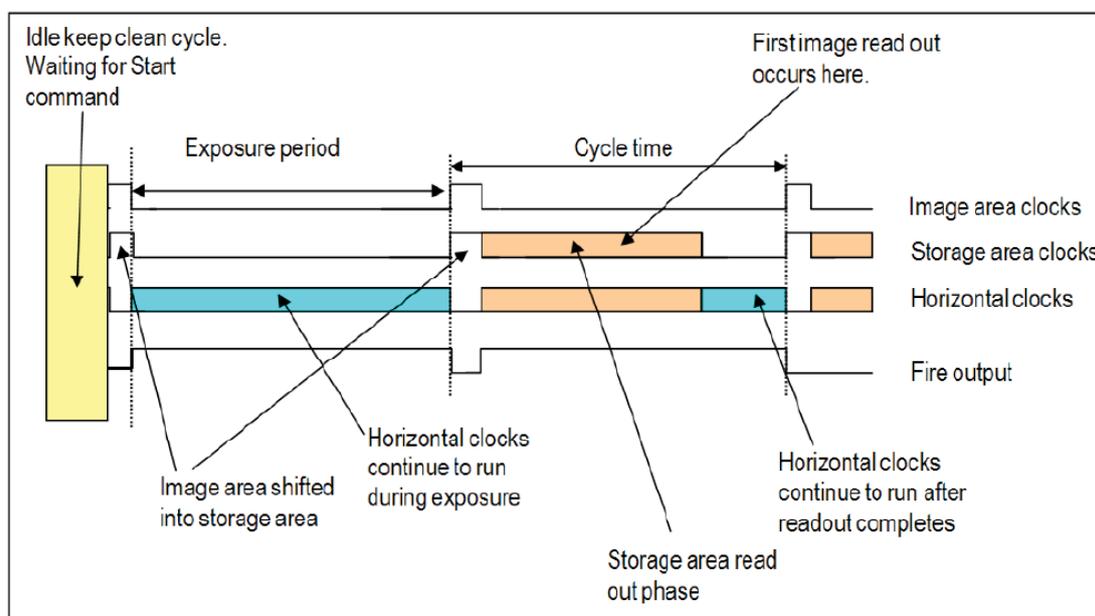


Figure 15: Internal Triggering in Frame Transfer Mode - Camera begins in idle keep clean, then once a cycle is interrupted, it finished it before shifting image area into the storage area. At that point the exposure begins. Blue sections: Clocks running continuously. Orange sections: Horz and Vert clocks alternating, running one row down, then reading it out.

In multiple exposure (i.e. kinetic series) mode the Fire output is high for much of the time. This is because there are no Keep Clean Cycles running between each acquisition, and hence the exposure time starts on completion of the transfer of the Image area into the Storage area. This also has the consequence that the exposure time and the cycle time are closely linked. We have defined the exposure time as the time during which there is no vertical shifting of the image area, which also corresponds to the time during which the Fire output will be high. The other point to note is that the exposure time overlaps the read out of the image.

4.3.2 EXTERNAL TRIGGERING

When the camera is idle, it runs the Idle Keep Clean Cycles described in **Section 4.1.1**. On receipt of the Start command from the PC, the camera goes into its External Keep Clean Cycles. The camera will repeat these cycles a minimum of X times, where X is the number of image rows on the sensor, before it will accept any External Trigger events. Once this period is over, the camera continues to run the External Keep Clean Cycles until an External Trigger is received. At that point the current External Keep Clean Cycle is completed, and the camera stops all vertical clocking and waits for the programmed user delay period before starting the read phase. During the readout phase the Image area is transferred rapidly to the Storage area. The Storage area is then read out in the normal way.

Once the readout is complete the camera continues to wait for the next external trigger event. During this period the shift register is continually clocked but the Image and Storage areas are not. On the next trigger the camera again waits for the programmed delay before starting the readout phase. The camera continues in this loop until the number of images requested has been captured. Because the Image area is not cleaned between trigger events, the effective exposure time is the time between events. The User Defined Delay is to allow for the capture of events which occur after the trigger pulse. In the case of the first trigger, the effective exposure time is given by the User Defined Delay since Keep Clean Cycles have been running up until the first trigger. This is in contrast to the subsequent exposure periods which are defined by the time between the external trigger events. Thus, for experimental protocols that involve Continuous Wave (CW) light the first image will be dimmer; some protocols may require that this image is discarded.

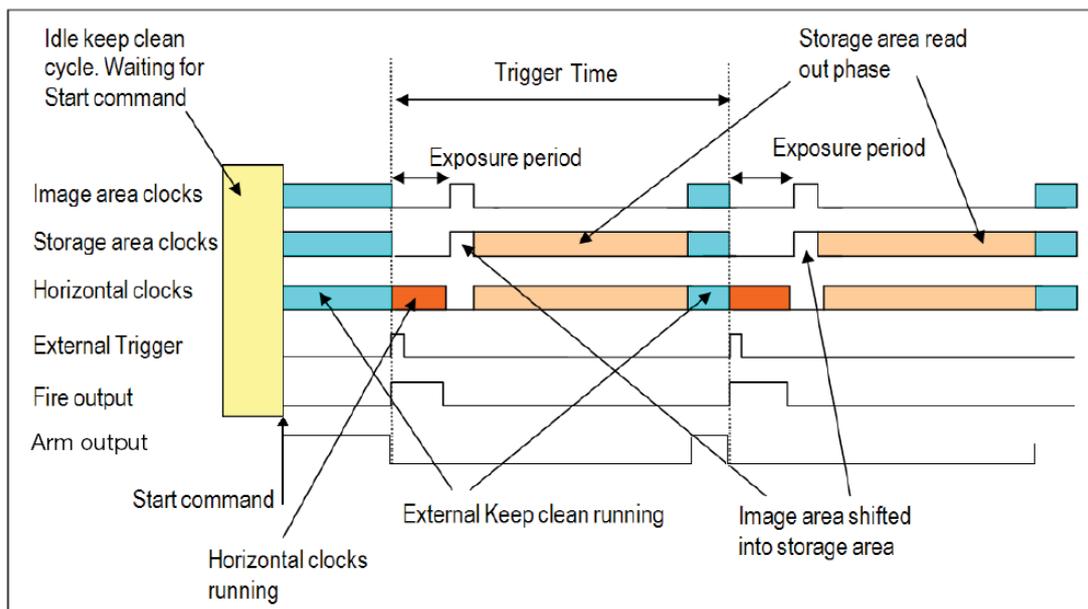


Figure 16: External Trigger in Frame transfer Mode

iCam

Since all iXon Ultra cameras have iCam technology, the rising edge of the external trigger can occur before the end of the previous read out, provided that the falling edge of the Fire pulse occurs after the readout has completed, i.e. the External Trigger is only accepted up to the 'User Defined Delay Period' before the end of the readout. This enhanced trigger mode will result in a higher frame rate (see **Figure 17**).

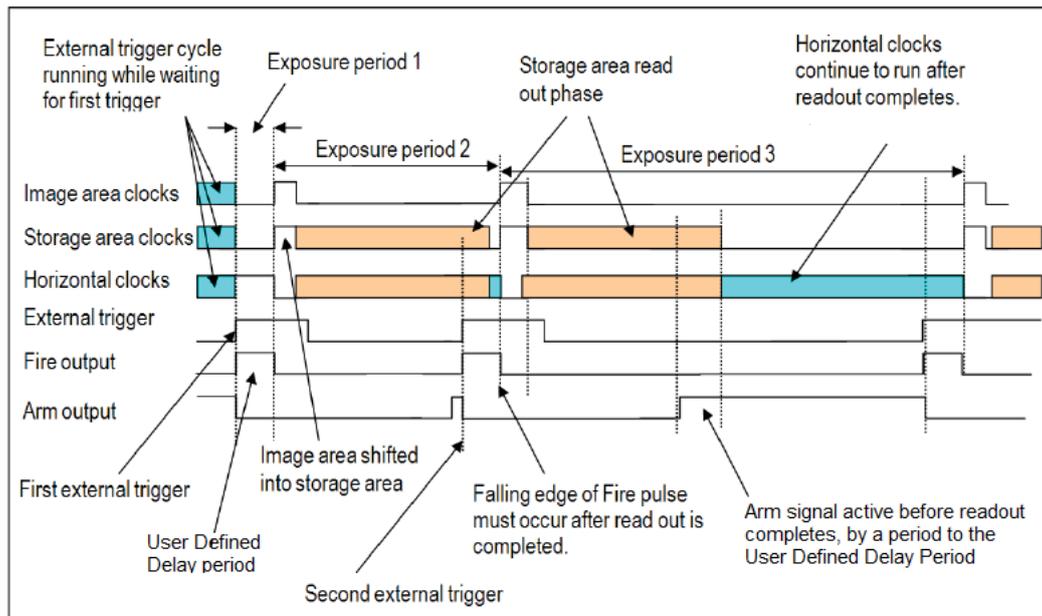


Figure 17: iCam-enhanced' External Trigger in Frame Transfer mode. For illustration only, the external triggers are shown with variable periods. Arm indicates when a trigger could be accepted and goes high based on the user defined delay period Ultra. iCam allows a trigger to be accepted while system is still being read out.

4.3.3 EXTERNAL EXPOSURE TRIGGERING

External Exposure Triggering mode is distinct from the triggering modes discussed previously, in that the exposure period is fully controlled by the width of the external trigger pulse. The exposure period starts on the positive edge and concludes on the negative edge. As illustrated in the timing diagrams below, the positive edge can occur either after the previous image has been completely read out, or while it is still being read. The ability to overlap the readout with the exposure period allows for very high frame rates. In order to ensure that light falling on the Image area before the start of the exposure does not contribute to the measured signal, the CCD is placed in a Keep Clean mode.

Although the start of the exposure can overlap the read out phase of the previous image, the end of the exposure cannot. This is because the end of the exposure is marked by shifting the Image area into the Storage area. It is not possible to use the same feature as is used to prevent light that fell before the exposure starts from contributing to the measured signal, as this would cause the already accumulated charge to be cleared.

NOTE: If the falling edge occurs during the read out phase it is ignored and the next falling edge will terminate the exposure.

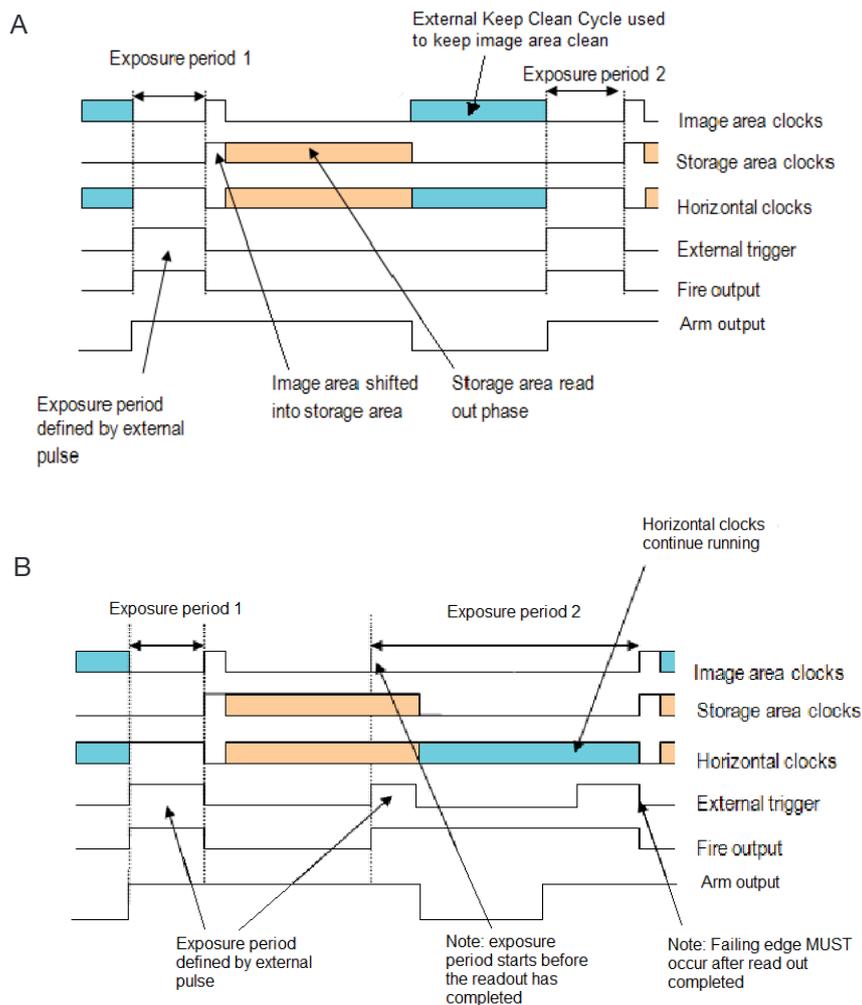


Figure 18: External Exposure Trigger in Frame Transfer Mode

4.4 TRIGGERING OPTIONS IN NON-FRAME TRANSFER (NFT) MODE

4.4.1 INTERNAL TRIGGERING (NFT)

In **Internal Triggering (NFT)** mode, when the camera is idle, it repeatedly runs the Idle Keep Clean Cycles. When the Start command is received from the PC, the camera completes the current Keep Clean Cycle, and then perform sufficient vertical shifts to ensure the Image and Storage regions are completely free of charge. The camera is then ready to start the real exposure sequence.

The timing sequence is illustrated in **Figure 19**. During exposure, the Fire output is high and there will be no vertical clocking. However, the horizontal register keeps running. On completion of the exposure time the FIRE pulse goes low and the Image area of the CCD will be shifted into the Storage area. As the acquired signal is now safely placed in the masked off region of the CCD, light still falling on the CCD will not contaminate the acquired image while it is being read out. On completion of the readout the camera will perform the Internal Keep Clean Cycles until the user specified cycle time has elapsed. This process continues until the complete series of acquisitions has taken place.

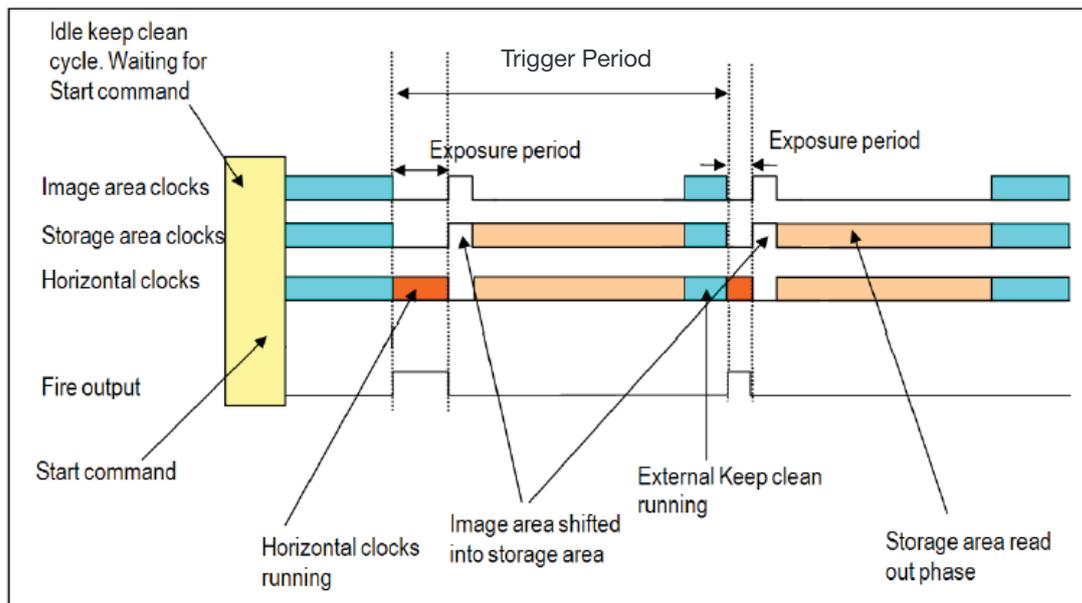


Figure 19: Internal Trigger in Non-Frame Transfer Mode.

4.4.2 EXTERNAL & FAST EXTERNAL (NFT) TRIGGERING

In the **External Triggering** modes, once an acquisition starts, the camera goes into “External Keep Clean’ Cycle (see **Section 4.1.3**). As can be seen from **Figure 20**, the External Keep Clean Cycle runs continuously until the first external trigger event is detected; at which point the system performs sufficient cycles to ensure the image area is fully cleaned, before it will accept an external trigger, at which point the exposure phase starts. During the exposure there are no vertical clocks running. There will, however, be horizontal clocks to ensure that the shift register continues to be kept clean. Once the exposure time has elapsed the charge built up in the Image area is quickly transferred into the Storage area. From the Storage area the charge is read out as normal. At the completion of the readout the camera restarts the External Keep Clean Cycles.

If the camera is in Fast External Trigger mode it will accept a trigger event immediately and start the next exposure, completing the current keep clean cycle, but not performing the number required to fully clear out the image area. Once this period has passed, Normal and Fast External Triggers operate in the same manner.

Fast External Trigger is useful in those cases where there is very little background light and the user is looking for the fastest frame rate. With Fast External Trigger, you may see variation in the background contribution to the signal from light that may have been allowed to fall on the sensor during the readout of the previous image. Fast external trigger does not mean that when a trigger is accepted the system will respond quicker than in normal external trigger mode.

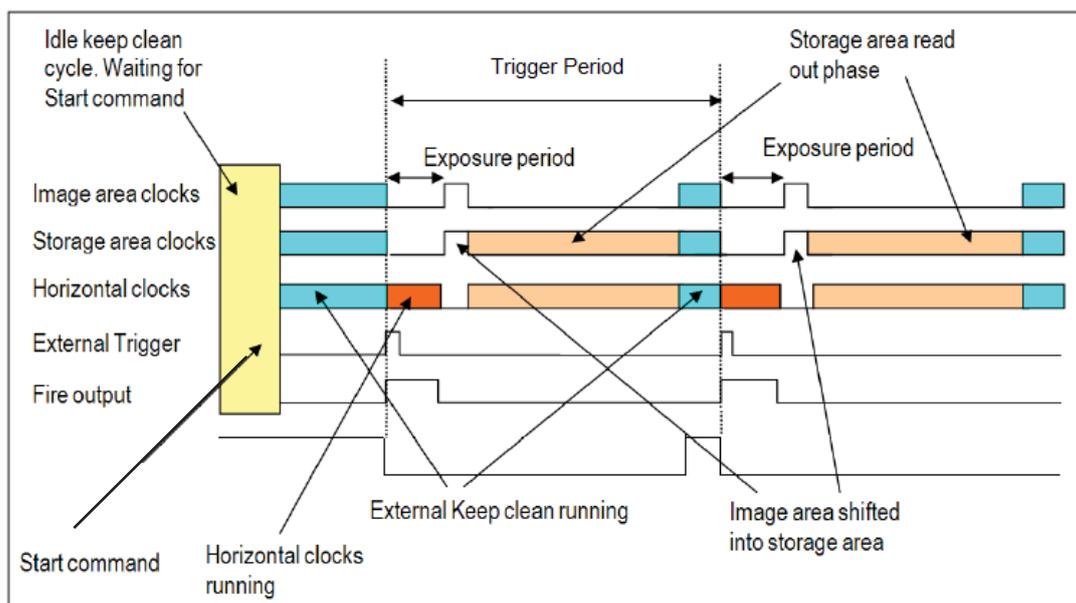


Figure 20: External Trigger in Non-Frame Transfer Mode

NOTE: There is no need to worry if the trigger occurs at the early phase of the Keep Clean Cycle, as the light signal will not be lost during the completion of the cycle since only one vertical shift will have occurred. For pulsed light of very short duration (of the order of one vertical shift), the resultant image may appear to have shifted one row.

4.4.3 EXTERNAL EXPOSURE (NFT) TRIGGERING

External Exposure (NFT) mode is distinct from the triggering modes covered previously, in that the exposure period is fully controlled by the width of the external trigger pulse. The exposure period starts on the positive edge and concludes on the negative edge. The exposure is physically ended by shifting the Image area into the Storage area. The Storage area is then readout in the normal manner.

On completion of the readout, the External Keep Clean Cycle is started again.

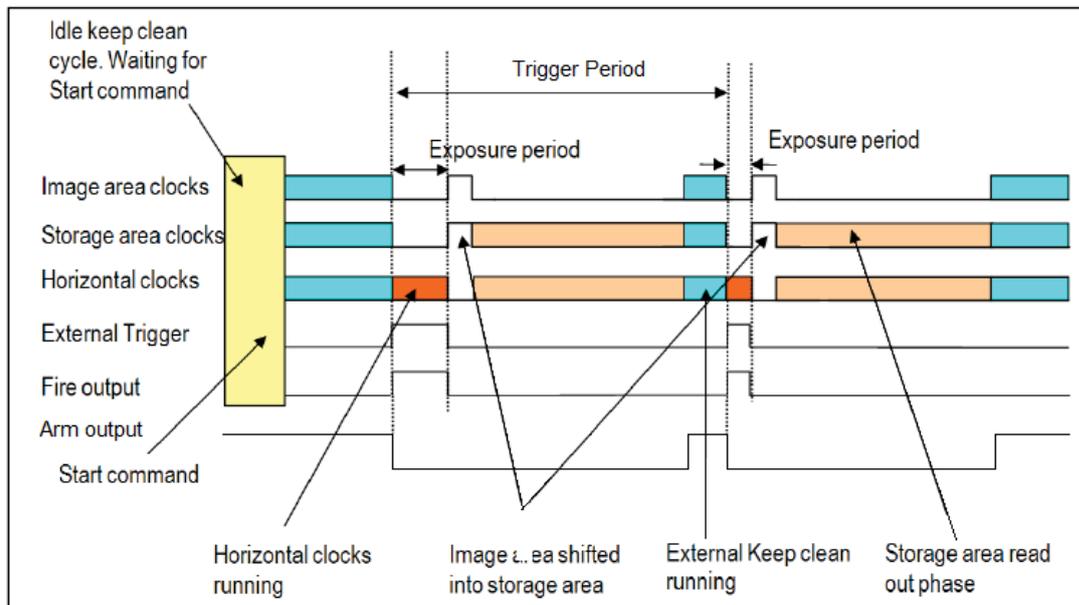


Figure 21: External Exposure (NFT) Triggering

4.4.4 SOFTWARE (NFT) TRIGGERING

This mode is particularly useful when the user needs to control other equipment between each exposure and does not know in advance how long such control will take, or if the time taken changes randomly. With Software Trigger, the camera and software are in a high state of readiness and can react extremely quickly to a trigger event issued via software.

In this mode the camera runs the Idle Keep Clean Cycle until the Start command is issued by the PC, which is identical to all the modes previously discussed. On receipt of this command, the camera switches to run the normal Internal Keep Clean Cycle until a Software Trigger command is issued by the PC. This event will start the exposure and readout sequence. On completion of the readout, the camera returns to the Internal Keep Clean Cycle until the next Software Trigger is issued.

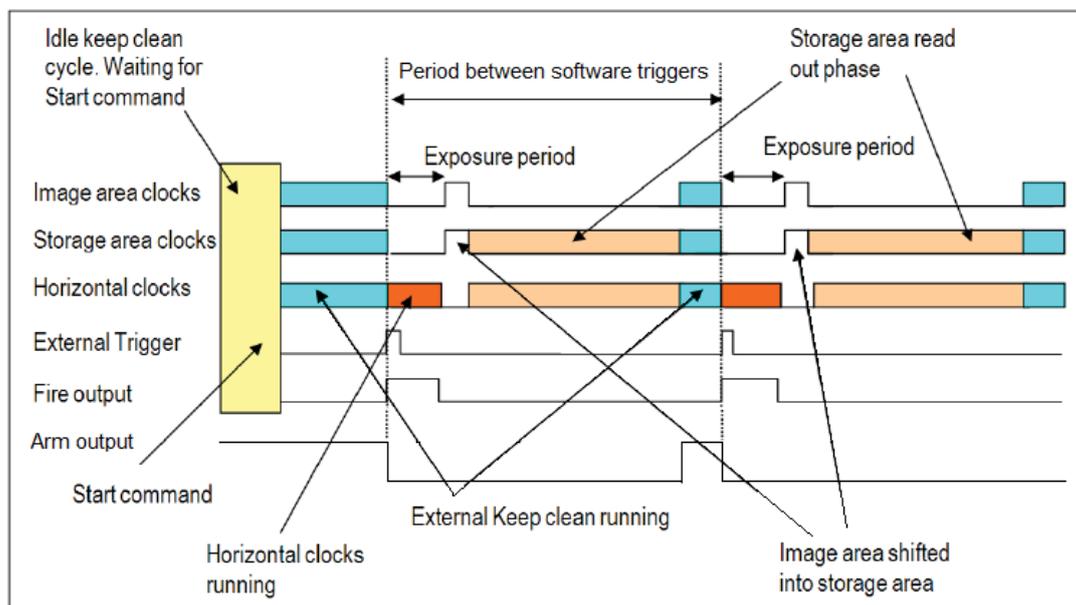


Figure 22: Software Triggering in Non-Frame transfer Mode

4.5 TRIGGERING OPTIONS IN FAST KINETICS (FK) MODE

4.5.1 INTERNAL (FK)

As **Fast Kinetics** uses both the Image and Storage areas as temporary storage areas, the number of options available is quite limited. The simplest mode is again **Internal Trigger** and, as with the internal trigger modes described previously, the system determines when the acquisition begins and then uses the exposure time defined by the user. On completion of the exposure period the camera performs the number of vertical shifts defined by the user, and then again waits for the exposure period before the next set of vertical shifts.

This process is repeated until the number in the series has been captured, at which point the readout starts. The timing sequence is shown in **Figure 23** and as before the Fire output envelopes the period when no vertical clocking is occurring. You will also see there are no readout cycles or Keep Clean Cycles running during the sequence, hence the very fast kinetic cycle period but limited number of exposures in the series.

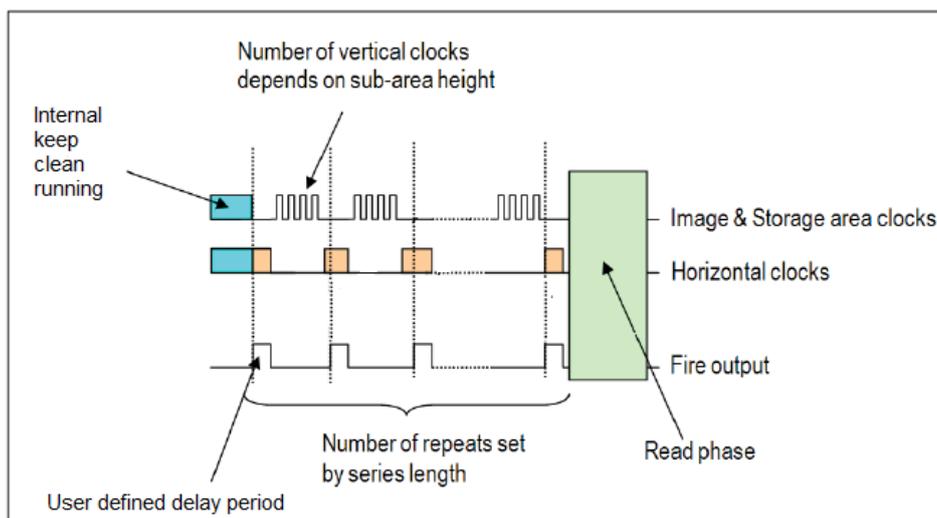


Figure 23: Internal Triggering in Fast kinetics Mode.

Note: Fire Pulse width is determined by “exposure time”. Timing between triggers is dictated by vertical shift speed and sub-area height. The effective exposure is a combination of both of these times.

4.5.2 EXTERNAL (FK)

In **External Trigger** mode, a trigger pulse is required to start each scan in the series. The rising edge of the trigger defines the trigger event. The user can delay the start of the vertical shifting relative to the trigger event. After the delay has elapsed, the number of rows (as specified by the user) are vertically shifted. The system then waits for the next trigger to start the next scan. As there is no Keep Clean Cycle running while waiting for the External Trigger, the 'real' exposure time is the time between each trigger. A consequence of this is that, if your experiment has a constant background signal but your trigger period is not fixed, you may see different background levels in your signal. As with internal trigger, the data is only read off the sensor when the capture sequence has completed.

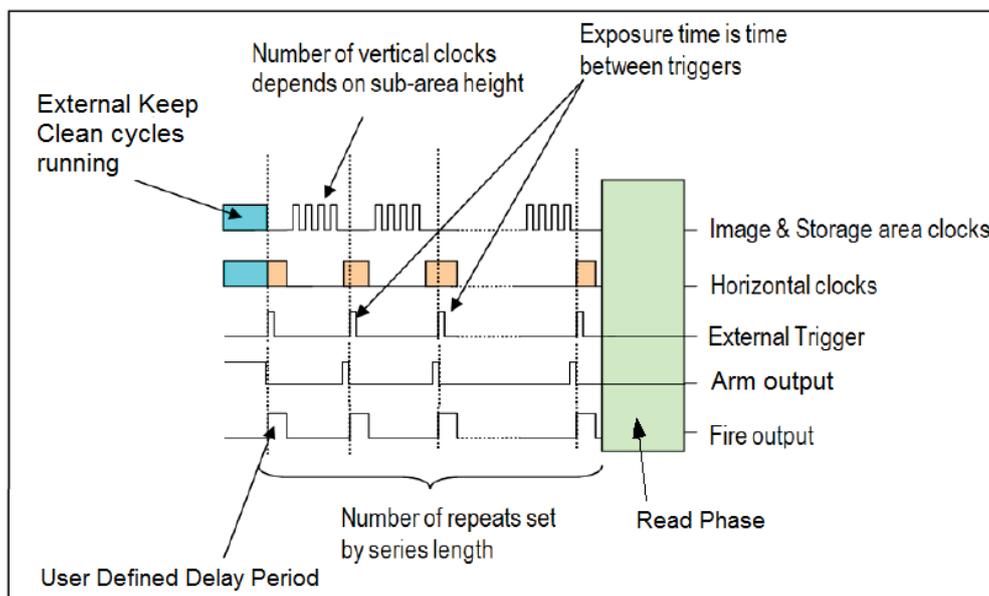


Figure 24: External Triggering in Fast Kinetics Mode

Note: Arm is low for the user defined delay period, plus the time it takes to perform the vertical shifts for the full sub-image

4.5.3 EXTERNAL START (FK)

External Start triggering mode is a combination of External and Internal Trigger. At the start of the capture process, the camera runs the External Keep Clean Cycle, waiting for a trigger pulse to be applied to the External Trigger input. On receiving the trigger the exposure starts. The exposure period is defined by the user. On completion of the exposure period, the camera performs the number of vertical shifts defined by the sub-area height (set by the user) and, then again, waits for the exposure period before the next set of vertical shifts. This process is repeated until the number in the series has been captured at which point the readout starts.

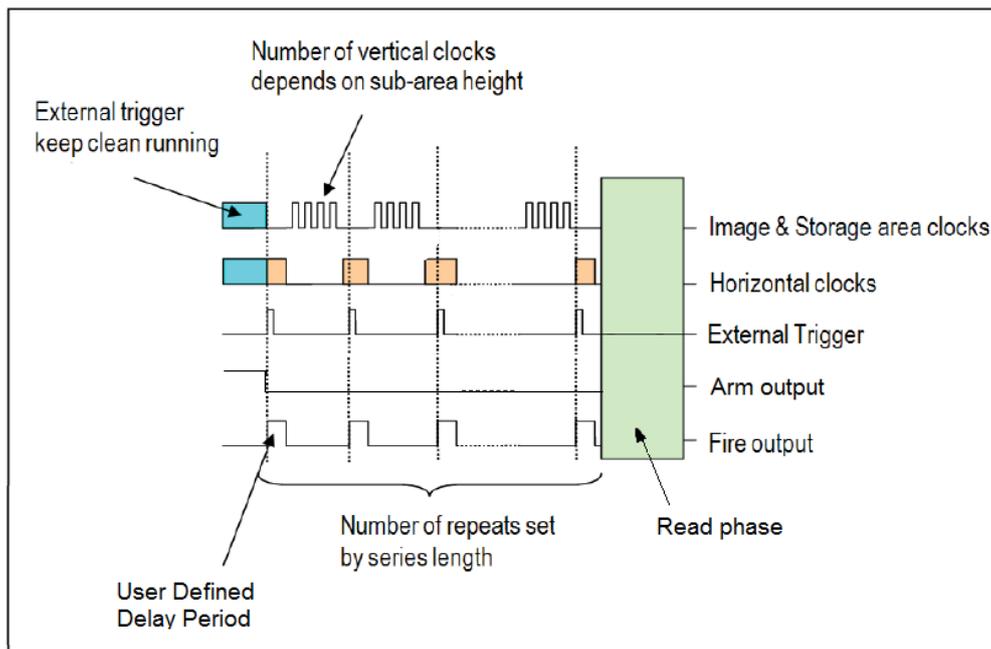


Figure 25: External Start Trigger in Fast Kinetics mode

TRIGGERING INFORMATION

4.6 IXON TRIGGERING DATA

The following section provides delay time, jitter and sensor sweep times for different operating speeds and vertical shift speeds for the different models in the iXon series.

4.6.1 IXON ULTRA 888

Vertical shift speed 4.33 μ S

Speed MHz	Typical delay (μ S)	pk-pk Jitter (μ S)	Sensor sweep time (ms)
30	0.268	+/-0.016	39.3
20	0.298	+/-0.031	56.8
10	0.384	+/-0.050	109.2
5	2.180	+/-0.480	214.0

Vertical shift speed 0.6 μ S

Speed MHz	Typical delay (μ S)	pk-pk Jitter (μ S)	Sensor sweep time (ms)
30	0.265	+/-0.017	35.5
20	0.259	+/-0.023	56.8
10	0.334	+/-0.050	109.2
5	2.180	+/-0.049	214.0

4.6.2 IXON ULTRA 897

Vertical shift speed 3.3 μ S

Speed MHz	Typical delay (μ S)	pk-pk Jitter (μ S)	Sensor sweep time (ms)
17	51.90	+/-19.7	15.7
10	57.70	+/-13.5	26.2
5	94.60	+/-21.6	52.4
1	393.00	+/-75.0	262.2

Vertical shift speed 0.3 μ S

Speed MHz	Typical delay (μ S)	pk-pk Jitter (μ S)	Sensor sweep time (ms)
17	51.90	+/-19.7	15.7
10	57.70	+/-13.5	26.2
5	94.60	+/-21.6	52.4
1	393.00	+/-75.0	262.2

4.6.3 iXON 3 (DU-897)

Vertical shift speed 12.9 μ S

Speed MHz	Typical delay (μ S)	pk-pk Jitter (μ S)	Sensor sweep time (ms)
10	11.20	+/-3.4	6.9
5	11.30	+/-3.4	6.9
3	11.67	+/-3.4	6.9
1	13.28	+/-3.6	6.9

Vertical shift speed 0.3 μ S

Speed MHz	Typical delay (μ S)	pk-pk Jitter (μ S)	Sensor sweep time (ms)
10	11.24	+/-3.2	6.9
5	11.35	+/-3.4	6.9
3	11.76	+/-3.4	6.9
1	13.58	+/-3.5	6.9

Notes:

Sensor sweep time is the time taken to clear the sensor of charge when in the idle state.

iXon Ultra series increase the sensor sweep time to improve measurement stability.

Triggered exposures with continuous illumination will require the camera to be operated at a higher readout speed.

SECTION 5: TROUBLESHOOTING

5.1 UNIT DOES NOT SWITCH ON

- Check power cord is plugged in and connected correctly to mains supply
- If applicable, replace fuse in the supplied mains cable as detailed in **Section 6.2.4**
- If the unit still does not switch on after the checks above have been carried out, contact Andor Technical Support

5.2 SUPPORT DEVICE NOT RECOGNISED WHEN PLUGGED INTO PC

- Choose another USB port
- Check connections

5.3 TEMPERATURE TRIP ALARM SOUNDS (CONTINUOUS TONE)

To protect the camera from overheating, a thermal switch has been attached to the heat sink. If the temperature of the heat sink rises above the predefined limit, the power supply to the cooler will cut off and a buzzer will sound. Should the buzzer sound ensure the following:

Air Cooling

- Check that the air vents on the sides of the detector head are not blocked
- There is sufficient clearance (100 mm) around the camera
- The ambient air temperature is not above 30°C
- The fan has not been deactivated (or the speed set too low) in software
- Check that no foreign bodies are obstructing the fan's rotation

Water Cooling

- That there is sufficient water flow passing through the camera head

NOTE: When using water cooling, always use water that is above the dew point of the ambient environment to prevent condensation from occurring.

The thermal cut-out will not reset until the camera has been powered off and the temperature of the metalwork reaches a predefined limit. Operation of the camera under conditions that cause repeated cut-outs is not recommended, as thermal cycling will unnecessarily cycle the components and solder joints in the system.

5.4 CAMERA HIGH FIFO FILL ALARM

The Ixon Ultra 888 supports USB 3.0. The camera will function in a USB 2.0 port – but will not sustain the full camera frame rate. Camera High FIFO fill alarms will likely occur if the Ultra 888 is used with a USB 2.0 PC port.

In addition, it has been observed in some systems that a camera may stop acquiring after approximately 1 - 10 seconds. When this occurs it has been found to be due to insufficient USB bandwidth. The camera includes a buffer (FIFO) to overcome any short term bandwidth reductions, however, sustained insufficient bandwidth will always cause the buffer to overflow – regardless of what size of buffer is used. The PC should be able to cope with a sustained USB data transfer of equal to or greater than 60 Megabytes/second. Modern machines should all be able to cope with this.

5.5 USB 3.0 INTER-OPERABILITY

USB 3.0 is a relatively new interface type, so it is possible that Inter-operability problems may occur.

Inter-operability problems could manifest as;

- Failure to detect connection of the iXon Ultra to the USB 3.0 port
- Failure to recognise the iXon Ultra in the device manager
- Intermittent loss of communication with the camera.
- Intermittent Camera FiFO fill alarms

If these occur, then check the firmware and driver status of the USB 3.0 interface on the PC or install the USB 3.0 card supplied with the camera.

SECTION 6: MAINTENANCE

6.1 CLEANING CAMERA EXTERIOR

Only use a dry, clean, lint free cloth to clean the painted surfaces. If necessary, use a water diluted mild detergent to lightly dampen the cloth- do not use Isopropyl alcohol, solvents or aerosols.

6.2 REGULAR CHECKS

The state of the product should be checked regularly, especially the following:

- The integrity of the enclosure
- Any water hoses used
- The AC/DC External Power Supply
- The mains cable



WARNING: Do not use equipment that is damaged.

6.2.1 ANNUAL ELECTRICAL SAFETY CHECKS

It is advisable to check the integrity of the insulation and protective earth of the product on an annual basis, e.g. U.K. PAT testing of the PS-90 Power supply.

6.3 REPLACEMENT PARTS

The supplied PS-90 PSU is the only recommended external power supply for use with the iXon camera. If this unit is faulty or damaged, please contact Andor for a replacement. Depending on the Terms and Conditions of your Warranty, you may be charged for this replacement. There are no user replaceable parts in the camera head- please contact your nearest Andor representative (see **Section 1.1**) if required.

6.4 FUSE REPLACEMENT

The camera itself does not have a fuse. However, if a U.K. (BS 1363) mains lead has been supplied, it contains a fuse, whose characteristics are as follow:

- Rated Current: 5 A
- Rated Voltage: 240 Vac
- Type: BS 1362
- Size: 6.3 × 25.4 mm (¼ × 1 inches) cartridge

For continued protection, always replace with a fuse of the same type and rating.



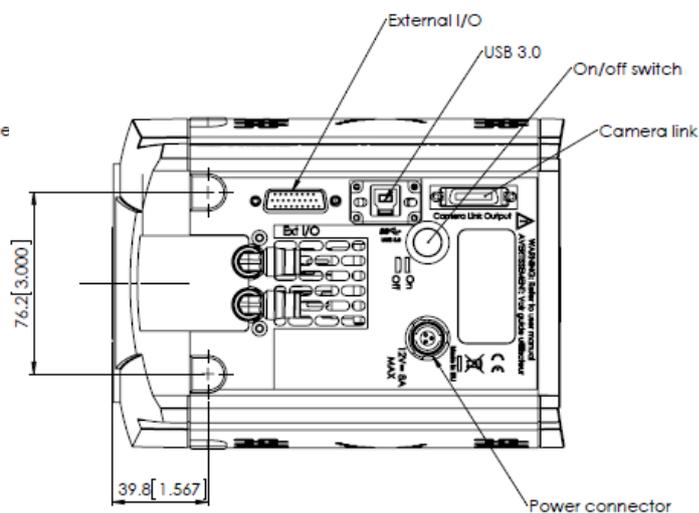
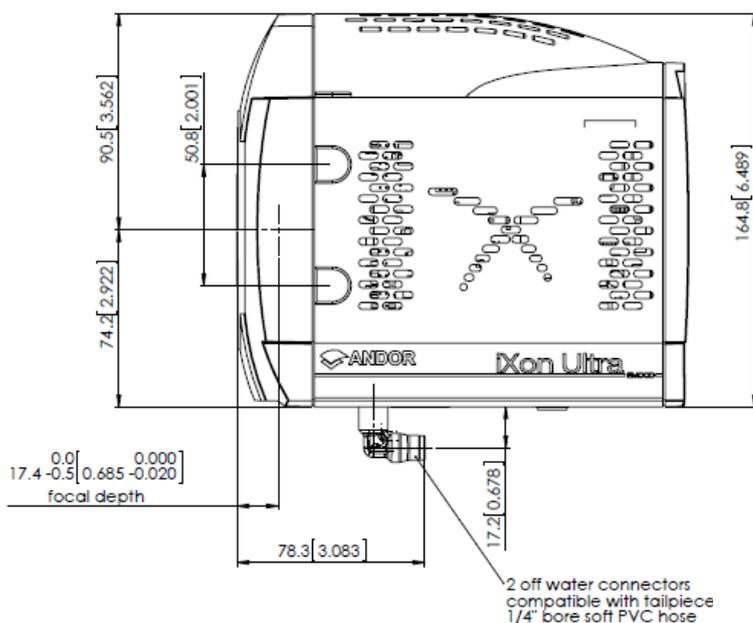
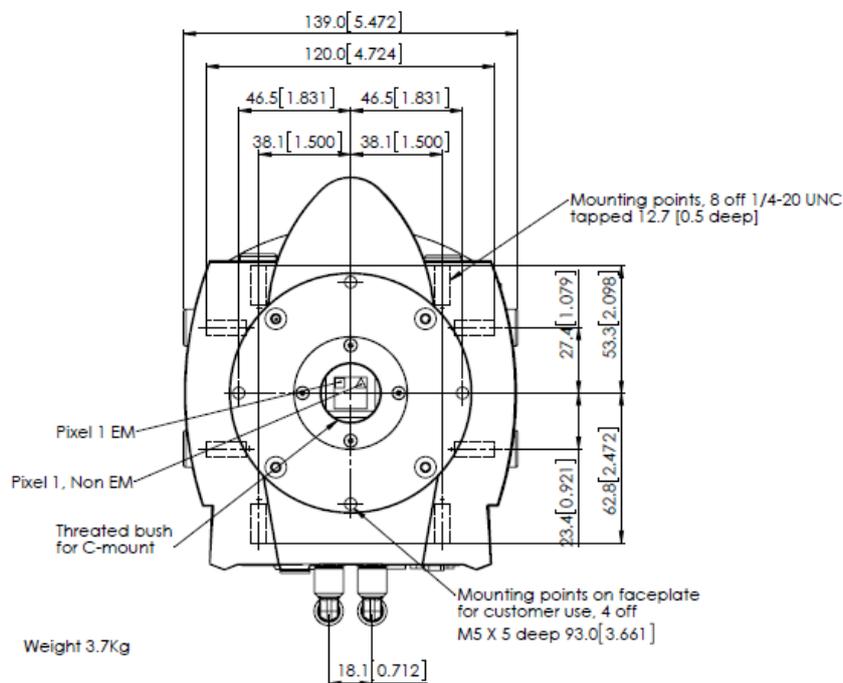
WARNING: Do not use equipment that is damaged.

SECTION 7: TECHNICAL SPECIFICATIONS

7.1 IXON ULTRA 888 SPECIFICATIONS

Power supply ratings	100 - 240 V, 47 - 63 Hz, 1.6 A
Location to be used	Indoor use only
Altitude	Up to 2000 m
Operating temperature range	0°C to 30°C
Storage temperature	-20°C to +55°C
Operating relative humidity	< 70% non-condensing
Overvoltage category	CAT II. An overvoltage category of CAT II means that the equipment is designed to cope with transient voltages above the rated supply that would be experienced by any product connected to a mains socket in a building
Pollution degree	Pollution degree 2. Normally only non-conductive POLLUTION occurs. Occasionally, however, a temporary conductivity caused by condensation must be expected.
Ingress protection rating	IP20
Cooling water flow rate	> 0.75 litre/minute
Control interface	USB 3.0
Electromagnetic compatibility	This is a Class A product. In a domestic environment this product may cause electromagnetic interference, in which case the user may be required to take adequate measures to shield adjacent equipment.
Cooling vent clearance	100 mm minimum
Dimensions	138 x 188 x 165 mm [5.44 x 7.41 x 6.50 inches]
Weight (camera only)	3.7 kg [8.2 lb]

APPENDIX A: MECHANICAL DRAWINGS



APPENDIX B: DEW POINT GRAPH

The relationship between Relative Humidity and Dew Point at varying Ambient Temperature is shown below. This can be used to calculate the minimum temperature the cooling water should be set to.

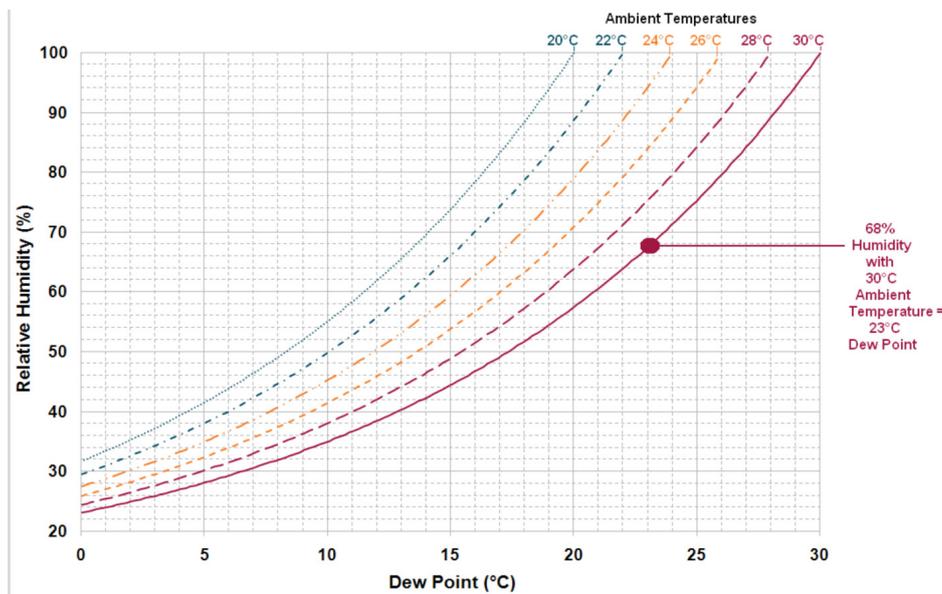


Figure 26: Calculation of dew point from ambient temperature and relative humidity

For example, when using an iXon Ultra 888, you will need 10°C cooling water to guarantee performance down to -95°C. In the relatively dry atmosphere of an air-conditioned lab, cooling water at 10°C should not present any problems.

However, in humid conditions (such as exist in some parts of the world) condensation may occur, resulting in damage to the head. In such conditions you will have to use warmer water (20°C or even higher if it is very humid). The minimum EMCCD temperature would then be limited to a higher value.

APPENDIX C: EMCCD TECHNOLOGY

WHAT IS AN ELECTRON MULTIPLYING CCD?

Electron **M**ultiplying **C**harge **C**oupled **D**evice (**EMCCD**) is a type of image sensor that is capable of detecting single photon events without an image intensifier (achievable by way of a unique electron multiplying structure built into the chip). Extremely weak signals may be detected above the read noise of the camera at any readout speed. This is important, because the traditional problem of combining sensitivity with speed in standard CCDs is that the two are mutually exclusive, i.e. greater read noise detection limits result from faster pixel readout.

DOES EMCCD TECHNOLOGY ELIMINATE READ OUT NOISE?

System noise within modern silicon based detectors has two primary sources: dark current noise and read noise. The higher the noise floor on a detector the less able it is to read out the extremely weak signals associated with ultra low-light imaging.

With thermoelectric cooling, dark current noise can be reduced to negligible levels. An EMCCD's ability to multiply weak signals above the detector's read noise floor, by applying EM Gain, effectively eliminates read noise at any speed by reducing it to $< 1 \text{ e-/p/s}$.

HOW SENSITIVE ARE EMCCDs?

Two parameters significantly influence detector sensitivity, namely Quantum Efficiency (QE) and system noise. QE is a measure of a camera's ability to capture valuable photons. A high QE results in more photons being converted to photoelectrons within the EMCCD pixels.

Once converted, the photoelectrons in a given pixel must overcome the detection limit or noise floor of the camera, which is set by the system noise. EMCCDs deliver superior sensitivity by maximizing QE and minimizing system noise, through the unique gain control feature. Single photon events are now well within the capabilities of super sensitive EMCCD technology.

WHAT APPLICATIONS ARE EMCCDs SUITABLE FOR?

EMCCD based detectors have been designed for the most demanding of low-light, dynamic applications. The detection limit is as low as single photons.

These levels of sensitivity are vital for low-light, life science and physical science imaging applications such as single molecule detection, live cell microscopy, weak luminescence detection, or demanding astronomy applications (to name only a few).

WHAT IS ANDOR TECHNOLOGY'S EXPERIENCE WITH EMCCDs?

Andor Technology was the first company to introduce an EMCCD based detector in 2000. Since then the company has led the way in the development of EMCCD detectors, introducing the first back illuminated EMCCD in January 2003. Andor now offers the widest range of EMCCD based detectors on the market. Please go to www.emccd.com for further details.

EMCCD SENSOR

All EMCCD sensors in the iXon Ultra range have a frame transfer architecture. The frame-transfer EMCCD uses a two-part sensor in which one-half of the array is used as a storage region and is protected from light by a light-tight mask. Incoming photons are allowed to fall on the uncovered portion of the array and the accumulated charge is then rapidly shifted into the masked storage region for transfer to the serial output register. While the signal is being integrated on the light-sensitive portion of the sensor, the stored charge is read out. Frame transfer devices have typically faster frame

rates than full frame devices, and have the advantage of a high duty cycle i.e. the sensor is always collecting light.

A potential disadvantage of this architecture is the charge smearing during the transfer from the light-sensitive to the masked regions of the EMCCD (although they are significantly better than full frame devices). The smearing is more prevalent when exposure times are closer to the time taken to shift the charge under the mask (in the order of milliseconds). With the iXon EMCCD series, vertical clock speeds can be tuned via the software to deliver the fastest parallel shifts which also results in faster overall frame rates (especially when using sub-array and/or pixel binning readout options).

The EMCCD sensor is capable of detecting single photon events without an image intensifier, achievable by way of a unique electron multiplying structure built into the chip. Traditional CCD cameras offered high sensitivity, with readout noises in single figure $< 10e^-$ but at the expense of slow readout. Hence they were often referred to as 'slow scan' cameras. The fundamental constraint came from the CCD charge amplifier. To have high speed operation the bandwidth of the charge amplifier needs to be as wide as possible. However, it is a fundamental principle that the noise scales with the bandwidth of the amplifier, hence higher speed amplifiers have higher noise.

Slow scan CCD's have relatively low bandwidth and hence can only be read out at modest speeds, typically less than 1MHz. EMCCD cameras avoid this constraint by amplifying the charge signal before the charge amplifier and hence maintain unprecedented sensitivity at high speeds. By amplifying the signal the readout noise is effectively by-passed and, as such, EMCCD readout noise is no longer a limit on sensitivity (and can often be considered negligible).

VACUUM HOUSING

Unless protected, cooled CCD sensors will condense moisture, hydrocarbons and other gas contaminants that will attack the CCD surface. If that happens, CCD performance will decline proportionally and will eventually fail. Fortunately, the integrity of the sensor can be preserved by housing it in a protective enclosure. However, it is important to understand that all such environments are not the same and the underlying technology used can seriously impact camera life (and performance).

OUTGASSING

Outgassing is the release of a gas trapped in a material. It is a problem encountered in high-vacuum applications. Materials not normally considered absorbent can release enough molecules to contaminate the vacuum and cause damage to optical sensors, window coatings, etc.

Even metals and glasses can release gases from cracks or impurities but sealants, lubricants and adhesives are the most common cause. Left unchecked, cooling performance would steadily degrade and therefore lead to increased dark current. Furthermore, resulting electrochemical reactions would eventually destroy the sensor.

ULTRAVAC™

A permanent hermetic vacuum head is an essential component of high-end imaging and spectroscopy EMCCD cameras. A permanent vacuum requires not only a hermetic seal, but also low outgassing- which sets the real limit on long-term performance. These criteria are what Andor's UltraVac™ vacuum process uniquely ensures.

Andor's proprietary UltraVac™ process minimizes outgassing, ensuring peak quantum efficiency and cooling will not degrade, even after years of operation. Temperature of the sensor can be reduced significantly (down to -100°C with an enhanced thermoelectric Peltier design) translating into substantially lower dark current and fewer blemishes. This is particularly critical to EMCCD technology, where even a single thermal electron is detected as a spurious noise spike. Elimination of condensation and outgassing means that the system can also use only a single entrance window, with antireflection coating so that QE of the system is maximized. All vacuum processes are carried out in a Class 1,000 clean room. Andor's UltraVac™ is a proven solution with over 10 years of supplying vacuum systems to the field with a negligible failure rate (Mean Time Between Failure (MTBF) of 100 years)

THERMOELECTRIC COOLER

The iXon Ultra range has a four-stage Peltier cooling assembly, which utilizes the thermoelectric effect to rapidly cool the sensor down to the stable operating temperature. TE coolers have a cold side (in contact with the sensor) and a hot side. Heat must be efficiently dissipated from the TE cooler for effective cooling of the sensor.

The iXon Ultra is designed to yield maximum heat dissipation, via either forced air cooling (in-built fan) or water cooling which, in combination with Andor's UltraVac™ vacuum process, results in market-leading cooling performance. A re-circulator or a chiller can be purchased from Andor to provide convenient and effective heat dissipation through water cooling.

The iXon Ultra camera also contains temperature control components, which regulate the cooling of the camera and ensure that a stable temperature is maintained between and throughout measurements.

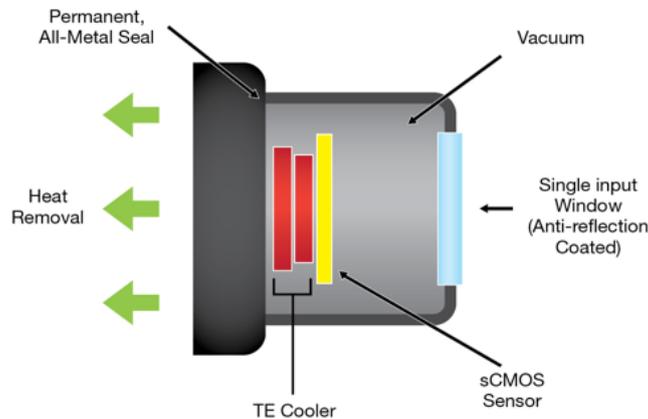


Figure 27: Ultravac™ metal hermetic vacuum sealing

APPENDIX D: GLOSSARY

This glossary provides an overview of the concepts and terminology used in Andor's EMCCD technology.

READOUT SEQUENCE OF AN EMCCD

In the course of readout, charge is moved vertically into the shift register then horizontally from the shift register into the output node of the amplifier. The simple readout sequence illustrated below (which corresponds to the default setting of the Full Resolution Image binning pattern) allows data to be recorded for each individual element on the EMCCD-chip. Other binning patterns are achieved by summing charge in the shift register and/or the output node prior to readout. For further information on binning, please refer to **Section 3.3.6 on page 48**).

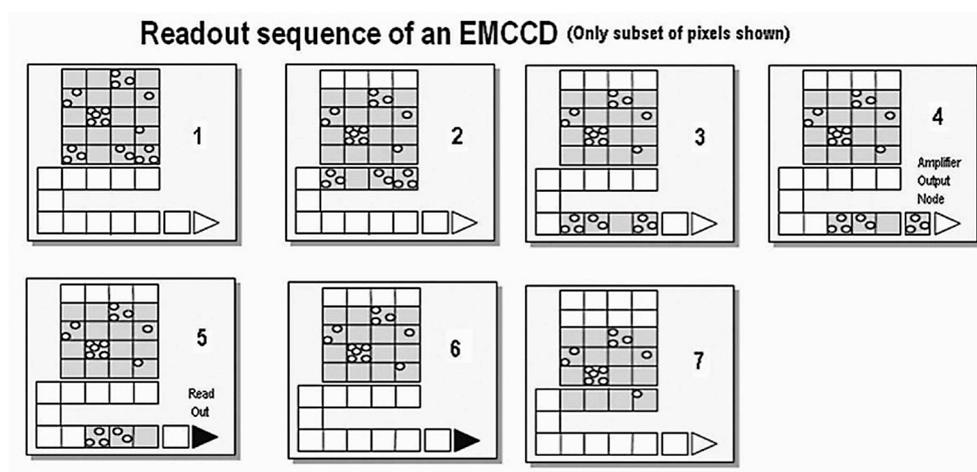


Figure 28: Readout sequence of an EMCCD

1. Exposure to light causes a pattern of charge (an electronic image) to build up on the frame (or Image Area) of the EMCCD-chip
2. Charge in the frame is shifted vertically by one row, so that the bottom row of charge moves into the shift register.
3. Charge in the shift register is moved horizontally by one pixel, so that charge on the endmost pixel of the shift register is moved into the Gain register.
4. Charge is shifted into the output node of the amplifier.
5. The charge in the output node of the amplifier is passed to the analog-to-digital converter and is read out.
6. Steps 3 and 4 are repeated until the shift register is emptied of charge.
7. The frame is shifted vertically again, so that the next row of charge moves down into the shift register.

The process is repeated from Step 3 until the whole frame is read out.

ACCUMULATION

Accumulation is the process by which data that have been acquired from a number of similar scans are added together in computer memory. This results in improved signal to noise ratio.

ACQUISITION

An **Acquisition** is taken to be the complete data capture process.

A/D CONVERSION

Charge from the EMCCD is initially read as an analogue signal, ranging from zero to the saturation value. **A/D conversion** changes the analogue signal to a binary (digital) number, which can then be manipulated by the computer.

BACKGROUND

Background is a data acquisition made in darkness. It is made up of fixed pattern noise, and any signal due to dark current.

BINNING

Binning is a process that allows charge from two or more pixels to be combined on the EMCCD-chip prior to readout.

COUNTS

Counts refer to the digitization by the A/D conversion and are the basic unit in which data are displayed and processed. Depending on the particular version of the detection device, one count may, for example, be equated with a charge of 10 photoelectrons on a pixel of the EMCCD.

DARK SIGNAL

Dark signal, a charge usually expressed as a number of electrons, is produced by the flow of dark current during the exposure time. All CCDs produce a dark current, an actual current that is measurable in (typically tenths of) milliamps per pixel. The dark signal adds to your measured signal level, and increases the amount of noise in the measured signal. Since the dark signal varies with temperature, it can cause background values to increase over time. It also sets a limit on the useful exposure time. Reducing the temperature of the EMCCD reduces dark signal (typically, for every 7°C that temperature falls, dark signal halves). EMCCD readout noise is low, and in order not to compromise this by shot noise from the dark signal, it is important to reduce the dark signal by cooling the detector. If you are using an exposure time of less than a few seconds, cooling the detector below 0°C will generally remove most of the shot noise caused by dark signal.

DETECTION LIMIT

The **Detection Limit** is a measure of the smallest signal that can be detected in a single readout. The smallest signal is defined as the signal whose level is equal to the noise accompanying that signal, i.e. a Signal to Noise ratio (S/N) of unity. Sources of noise are as shown hereunder:

- Shot noise of the signal itself
- Shot noise of any dark signal
- Readout noise

If the signal is small, we can ignore its shot noise. Furthermore, if a suitably low operating temperature and short exposure time can be achieved, the lowest detection limit will equal the readout noise.

EXPOSURE TIME

The **Exposure Time** is the period during which the EMCCD collects light prior to readout.

FRAME TRANSFER

Frame transfer is a special acquisition mode that is only available if your system contains a Frame Transfer (FT) CCD or EMCCD. The iXon Ultra has an FT EMCCD acquisition mode. An FT CCD or EMCCD differs from a standard CCD or EMCCD in 2 ways. Firstly, it contains 2 areas of approximately equal size as shown below:

1. The first area is the **Image Area**, which is located at the top and farthest from the readout register. This is the light sensitive area of the CCD.
2. The second section is the **Storage Area**, and is located between the Image Area and the readout register. This section is covered by an opaque mask, usually a metal film, and hence is not sensitive to light.

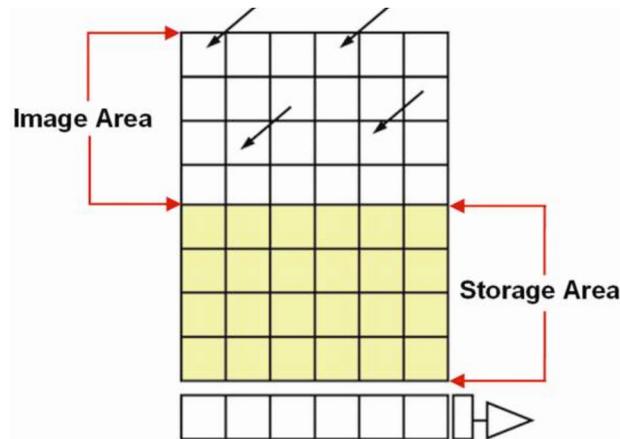


Figure 29: Frame transfer

The second way in which a FT CCD differs from a standard CCD is that the Image and Storage areas can be shifted independently of each other. These differences allow FT capable CCD or EMCCD devices to be operated in a unique mode where one image can be read out while the next image is being acquired. It also allows a them to be used in imaging mode without a shutter. Note: This is only applicable when the camera is running in Accumulate or Kinetic mode.

NOISE

PIXEL NOISE

The **Pixel Noise** is the variation in the pixel's charge level when exposed to a constant signal flux over a significantly valid period of read levels. The pixel noise is normally expressed as the value of the Root Mean Square (rms) of these variations.

NOTE: The rms value is approximately x 4 to x 6 smaller than the peak to peak variations in the level values read from the pixel.

Pixel Noise has three main constituents:

- Readout noise
- Shot noise from the dark signal
- Shot noise from the light signal itself

Shot noise cannot be removed due to the laws of Physics. Most simply defined, shot noise is the squareroot of the signal (or dark signal) measured in electrons.

READOUT NOISE

Readout noise is due to the amplifier and electronics. It is independent of dark signal and signal levels, and is only very slightly dependent on temperature. It is present on every readout, as a result of which it sets a limit on the best achievable noise performance.

SHOT NOISE

Shot Noise is due to the basic laws of physics and cannot be removed. Any signal, whether it is a dark signal or a light signal, will have shot noise associated with it. Shot noise is a statistical variation in signal level which follows a Poisson distribution. The shot noise relates to the generating signal by the following relationship:-

If the signal or dark signal = N electrons, then the shot noise is the square root of N.

You can do nothing about the shot noise of your signal, but by choosing minimum exposures and operating the EMCCD at suitably low temperatures, the dark signal, and consequently the noise from the dark signal, can be reduced.

SHOT NOISE FROM THE SIGNAL

Shot noise from the signal is caused by dependence on the signal generated by the light falling onto the sensor.

SHOT NOISE FROM THE DARK SIGNAL

Shot noise from the dark signal is related to the electrons generated within the sensor, Dark Current etc. Therefore it is dependent on the exposure time and it is very dependent on the temperature.

CALCULATION OF TOTAL PIXEL NOISE

The **total pixel noise** is not simply the sum of the three main noise components (readout noise, shot noise from the dark signal and shot noise from the signal). Rather, the rms gives a reasonable approximation - thus:

$$\text{total} = \text{sqrt}(\text{readnoise}^2 + \text{darkshot}^2 + \text{sigshot}^2)$$

where:

- total is the pixel noise
- readnoise is the readout noise
- darkshot is the shot noise of the dark signal
- sigshot is the shot noise of the signal

FIXED PATTERN NOISE

Fixed Pattern Noise (FPN) consists of the differences in count values read out from individual pixels, even if no light is falling on the detector. These differences remain constant from read to read. The differences are due in part to a variation in the dark signal produced by each pixel, and in part to small irregularities that arise during the fabrication of the EMCCD and in part to settling time of the electronics. Since fixed pattern noise is partly due to dark signal, it will change if the temperature changes but, because it is fixed, it can be completely removed from a measurement by background subtraction.

QUANTUM EFFICIENCY/SPECTRAL RESPONSE

The glossary refers to signals as a number of electrons. Strictly speaking, these are “photoelectrons” created when a photon is absorbed. When a UV or visible photon is absorbed by the detector it can, at best, produce only one photoelectron. Photons of different wavelengths have different probabilities of producing a photoelectron, and this probability is usually expressed as **Quantum Efficiency (QE)** or **Spectral Response**.

QE is a percentage measure of the probability of a single photon producing a photoelectron, while spectral response is the number of electrons that will be produced per unit photon energy. Many factors contribute to the QE of a EMCCD, but the most significant factor is the absorption coefficient of the silicon that serves as the bulk material of the device.

READOUT

Readout is the process by which data are taken from the pixels of the EMCCD and stored in computer memory. The pixels, which are arranged in a single row, are read out individually in sequence. Readout involves amplifying the charge on each pixel into a voltage, performing an analog to digital conversion and then storing the data in computer memory. The time taken to perform this operation is known as the “read time”.

SATURATION

Saturation is the largest signal the EMCCD can measure. A signal is measured in terms of the amount of charge that has built up in the individual pixels on the EMCCD-chip. A number of factors determine the maximum amount of charge that the EMCCD can handle.

SCANS (KEEP CLEAN AND ACQUIRED)

The EMCCD is continually being “scanned” to prevent its becoming saturated with dark current (see Appendix **Dark Signal**).

- If the scan is being used simply to “clean” the EMCCD (i.e. it is a keep-clean scan), the charge from the EMCCD is discarded
- In an acquired scan, however, the charge undergoes analog to digital conversion and is acquired into computer memory so that it can be used for subsequent processing and display: it is “read out” (see **Readout** above)

Unless the context specifically indicates otherwise, “scan”, in this User Guide, generally refers to an acquired scan.

SHIFT REGISTER

The **Shift Register** usually consists of a single row of elements (or pixels) running parallel to, and below, the bottom row of light-gathering pixels (the image area) on the EMCCD-chip. The shift register is protected from light by an aluminium mask. The elements in the shift register have a greater capacity to store charge (i.e. a greater “well depth”) than the other pixels on the EMCCD-chip.

SIGNAL TO NOISE RATIO

The **Signal to Noise Ratio** (commonly abbreviated as **S/N** or **SNR**) is the ratio between a given signal and the noise associated with that signal. Noise has a fixed component and a variable component (shot noise), which is the square root of the signal. Thus, the S/N usually increases (improves) as the signal increases.

The maximum S/N is the ratio between the maximum signal (i.e. the saturation level) and the noise associated with that signal. At near saturation levels the dominant source of noise is the shot noise of the signal.

APPENDIX E: OTHER INFORMATION

TERMS AND CONDITIONS OF SALE AND WARRANTY INFORMATION

The terms and conditions of sale, including warranty conditions, will have been made available during the ordering process. The current version may be viewed at: http://www.andor.com/pdfs/literature/Andor_Standard_Warranty.pdf

WASTE ELECTRONIC AND ELECTRICAL EQUIPMENT REGULATIONS 2006 (WEEE)

The company's statement on the disposal of WEEE can be found in the Terms and Conditions

